

16-bit Proprietary Microcontroller

CMOS

F²MC-16LX MB90860A Series

MB90F867A (S) , MB90867A (S)

■ DESCRIPTION

The MB90860A-series is Fujitsu 16-bit general-purpose microcontroller which enhances each kind of timers and communication macros. With the new 0.35 μm CMOS technology, Fujitsu now offers 128 Kbytes on-chip FLASH-ROM program memory. An internal voltage booster removes the necessity for a second programming voltage.

The power supply (3 V) is supplied to the internal MCU core from an internal regulator circuit. This creates a major advantage in terms of EMI and power consumption.

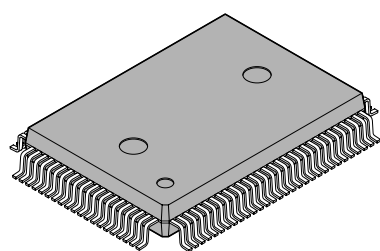
The internal PLL clock frequency multiplier provides an internal 42 ns instruction cycle time from an external 4 MHz clock.

The unit features an 8 channel Output Compare Unit and 8 channel Input Capture Unit with 2 separate 16-bit free running timers. 4 UARTs constitute additional functionality for communication purposes.

Note : F²MC stands for FUJITSU Flexible Microcontroller, a registered trademark of FUJITSU LIMITED.

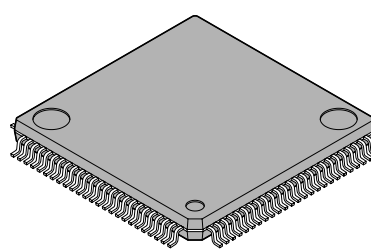
■ PACKAGES

100-pin Plastic QFP



(FPT-100P-M06)

100-pin Plastic LQFP



(FPT-100P-M05)

MB90860A Series

■ FEATURES

• Clock

- Built-in PLL clock frequency multiplication circuit
- Selection of machine clocks (PLL clocks) is allowed among frequency division by two on oscillation clock, and multiplication of 1 to 6 times of oscillation clock (for 4 MHz oscillation clock, 4 MHz to 24 MHz).
- Operation by sub-clock (up to 50 kHz : 100 kHz oscillation clock divided by two) is allowed. (devices without S-suffix only)
- Minimum execution time of instruction : 42 ns (when operating with 4-MHz oscillation clock, and 6-time multiplied PLL clock).

• 16 Mbyte CPU memory space

- 24-bit internal addressing

• Instruction system best suited to controller

- Wide choice of data types (bit, byte, word, and long word)
- Wide choice of addressing modes (23 types)
- Enhanced multiply-divide instructions and RETI instructions
- Enhanced high-precision computing with 32-bit accumulator

• Instruction system compatible with high-level language (C language) and multitask

- Employing system stack pointer
- Enhanced various pointer indirect instructions
- Barrel shift instructions

• Increased processing speed

- 4-byte instruction queue

• Powerful interrupt function

- Powerful 8-level, 34-condition interrupt feature
- Up to 16 external interrupts are supported

• Automatic data transfer function independent of CPU

- Extended intelligent I/O service function (EI²OS) : up to 16 channels
- DMA : up to 16 channels

• Low power consumption (standby) mode

- Sleep mode (a mode that halts CPU operating clock)
- Time-base timer mode (a mode that operates oscillation clock, sub clock, time-base timer and clock timer only)
- Watch mode (a mode that operates sub clock and clock timer only)
- Stop mode (a mode that stops oscillation clock and sub clock)
- CPU blocking operation mode

• Process

- CMOS technology

• I/O port

- General-purpose input/output port (CMOS output)
 - 80 ports (devices without S-suffix)
 - 82 ports (devices with S-suffix)

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- **Timer**

- Time-base timer, clock timer, watchdog timer : 1 channel
- 8/16-bit PPG timer : 8-bit X 16 channels, or 16-bit X 8 channels
- 16-bit reload timer : 4 channels
- 16-bit input/output timer
 - 16-bit free run timer : 2 channel (FRT0 : ICU 0/1/2/3, OCU 0/1/2/3, FRT1 : ICU 4/5/6/7, OCU 4/5/6/7)
 - 16-bit input capture: (ICU) : 8 channels
 - 16-bit output compare : (OCU) : 8 channels

- **UART (LIN/SCI) : 4 channels**

- Equipped with full-duplex double buffer
- Clock-asynchronous or clock-synchronous serial transmission is available

- **I²C interface* : 2 channels**

- Up to 400 kbit/s transfer rate

- **DTP/External interrupt : 16 channels, CAN wakeup : 2 channels**

- Module for activation of extended intelligent I/O service (EI²OS), DMA, and generation of external interrupt.

- **Delay interrupt generator module**

- Generates interrupt request for task switching.

- **8/10-bit A/D converter : 24 channels**

- Resolution is selectable between 8-bit and 10-bit.
- Activation by external trigger input is allowed.
- Conversion time : 3 μ s (at 24-MHz machine clock, including sampling time)

- **Program patch function**

- Address matching detection for 6 address pointers.

- **Internal voltage regulator**

- Supports 3 V MCU core, offering low EMI and low power consumption figures

- **Programmable input levels**

- Automotive/CMOS-Schmitt (initial level is Automotive in Single chip mode)
- TTL level (initial level for External bus mode)

- **ROM security function**

- Protects the content of ROM (MASK ROM device only)

- **Flash security function**

- Protects the content of Flash (Flash device only)

- **External bus interface**

- **Clock monitor function**

* : I²C license :

Purchase of Fujitsu I²C components conveys a license under the Philips I²C Patent Rights to use, these components in an I²C system provided that the system conforms to the I²C standard Specification as defined by Philips.

MB90860A Series

■ PRODUCT LINEUP

Part Number Parameter	MB90F867A (S) , MB90867A (S)	MB90V340(S)
CPU	F ² MC-16LX CPU	
System clock	On-chip PLL clock multiplier (×1, ×2, ×3, ×4, ×6, 1/2 when PLL stops) Minimum instruction execution time : 42 ns (4 MHz osc. PLL × 6)	
ROM	Boot-block,Flash memory 128 Kbytes	External
RAM	6 Kbytes	30 Kbytes
Emulator-specific power supply*1	—	Yes
Technology	0.35 μm CMOS with on-chip voltage regulator for internal power supply + Flash memory with On-chip charge pump for programming voltage	0.35 μm CMOS with on-chip voltage regulator for internal power supply
Operating voltage range	3.5 V to 5.5 V : at normal operating (not using A/D converter) 4.0 V to 5.5 V : at using A/D converter/Flash programming 4.5 V to 5.5 V : at using external bus	5 V ± 10%
Temperature range	−40 °C to +105 °C	—
Package	QFP-100, LQFP-100	PGA-299
UART	4 channels	5 channels
	Wide range of baud rate settings using a dedicated reload timer Special synchronous options for adapting to different synchronous serial protocols LIN functionality working either as master or slave LIN device	
I ² C (400 Kbit/s)	2 channel	
A/D Converter	24 input channels	
	10-bit or 8-bit resolution Conversion time : Min 3 μs include sample time (per one channel)	
16-bit Reload Timer (4 channels)	Operation clock frequency : fsys/2 ¹ , fsys/2 ³ , fsys/2 ⁵ (fsys = Machine clock frequency) Supports External Event Count function	
16-bit I/O Timer (2 channels)	Signals an interrupt when overflowing Supports Timer Clear when a match with Output Compare (Channel 0, 4) Operation clock freq. : fsys, fsys/2 ¹ , fsys/2 ² , fsys/2 ³ , fsys/2 ⁴ , fsys/2 ⁵ , fsys/2 ⁶ , fsys/2 ⁷ (fsys = Machine clock freq.) I/O Timer 0 (clock input FRCK0) corresponds to ICU 0/1/2/3, OCU 0/1/2/3 I/O Timer 1 (clock input FRCK1) corresponds to ICU 4/5/6/7, OCU 4/5/6/7	
16-bit Output Compare (8 channels (16-bit) / 16 channels (8-bit))	Signals an interrupt when 16-bit I/O Timer match output compare registers. A pair of compare registers can be used to generate an output signal.	
16-bit Input Capture (8 channels)	Rising edge, falling edge or rising & falling edge sensitive Signals an interrupt upon external event	

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MB90860A Series

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Part Number Parameter	MB90F867A (S) , MB90867A (S)	MB90V340(S)
8/16-bit Programmable Pulse Generator (8 channels)	Supports 8-bit and 16-bit operation modes Sixteen 8-bit reload counters Sixteen 8-bit reload registers for L pulse width Sixteen 8-bit reload registers for H pulse width A pair of 8-bit reload counters can be configured as one 16-bit reload counter or as 8-bit prescaler plus 8-bit reload counter Operation clock freq. : f_{sys} , $f_{sys}/2^1$, $f_{sys}/2^2$, $f_{sys}/2^3$, $f_{sys}/2^4$ or $128 \mu s @ f_{osc} = 4 \text{ MHz}$ (f_{sys} = Machine clock frequency, f_{osc} = Oscillation clock frequency)	
CAN Interface	—	3 channels
External Interrupt (16 channels)	Can be used rising edge, falling edge, starting up by H/L level input, external interrupt, expanded intelligent I/O services (EI ² OS) and DMA	
D/A converter	—	2 channels
Up to 100 kHz Subclock for low power operation	devices with 'S'-suffix : without subclock devices without 'S'-suffix : with subclock	
I/O Ports	Virtually all external pins can be used as general purpose I/O port All push-pull outputs Bit-wise settable as input/output or peripheral signal Settable in pin-wise of 8 as CMOS schmitt trigger/ automotive inputs (default) TTL input level settable for external bus (32-pin only for external bus)	
Flash Memory	Supports automatic programming, Embedded Algorithm ^{TM*2} Write/Erase/Erase-Suspend/Resume commands A flag indicating completion of the algorithm Number of erase cycles : 10,000 times Data retention time : 20 years Boot block configuration Erase can be performed on each block Block protection with external programming voltage Flash Security Feature for protecting the content of the Flash	—

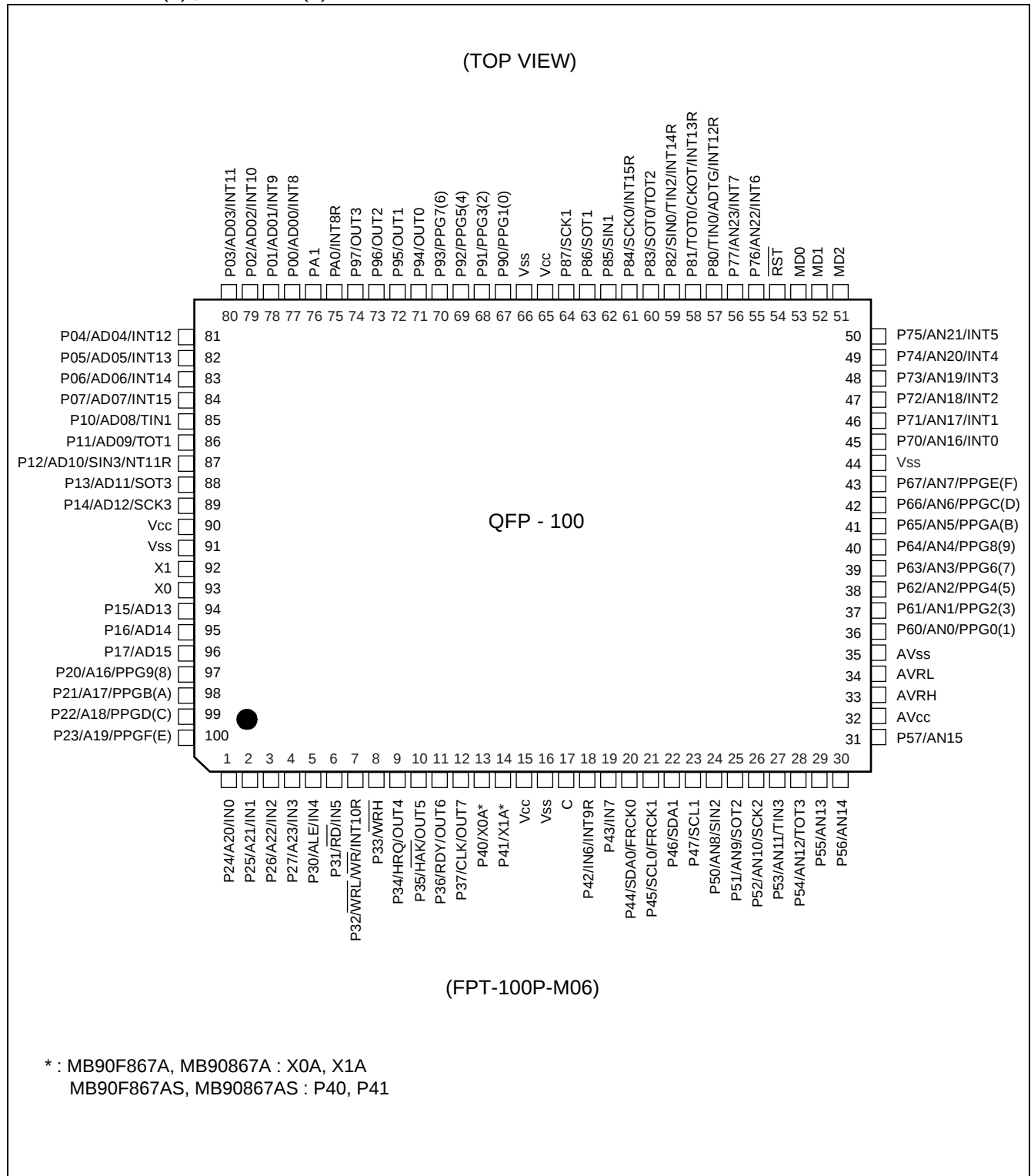
*1 : It is setting of Jumper switch (TOOL VCC) when Emulator (MB2147-01) is used.
Please refer to the Emulator hardware manual about details.

*2 : Embedded Algorithm is a trade mark of Advanced Micro Devices Inc.

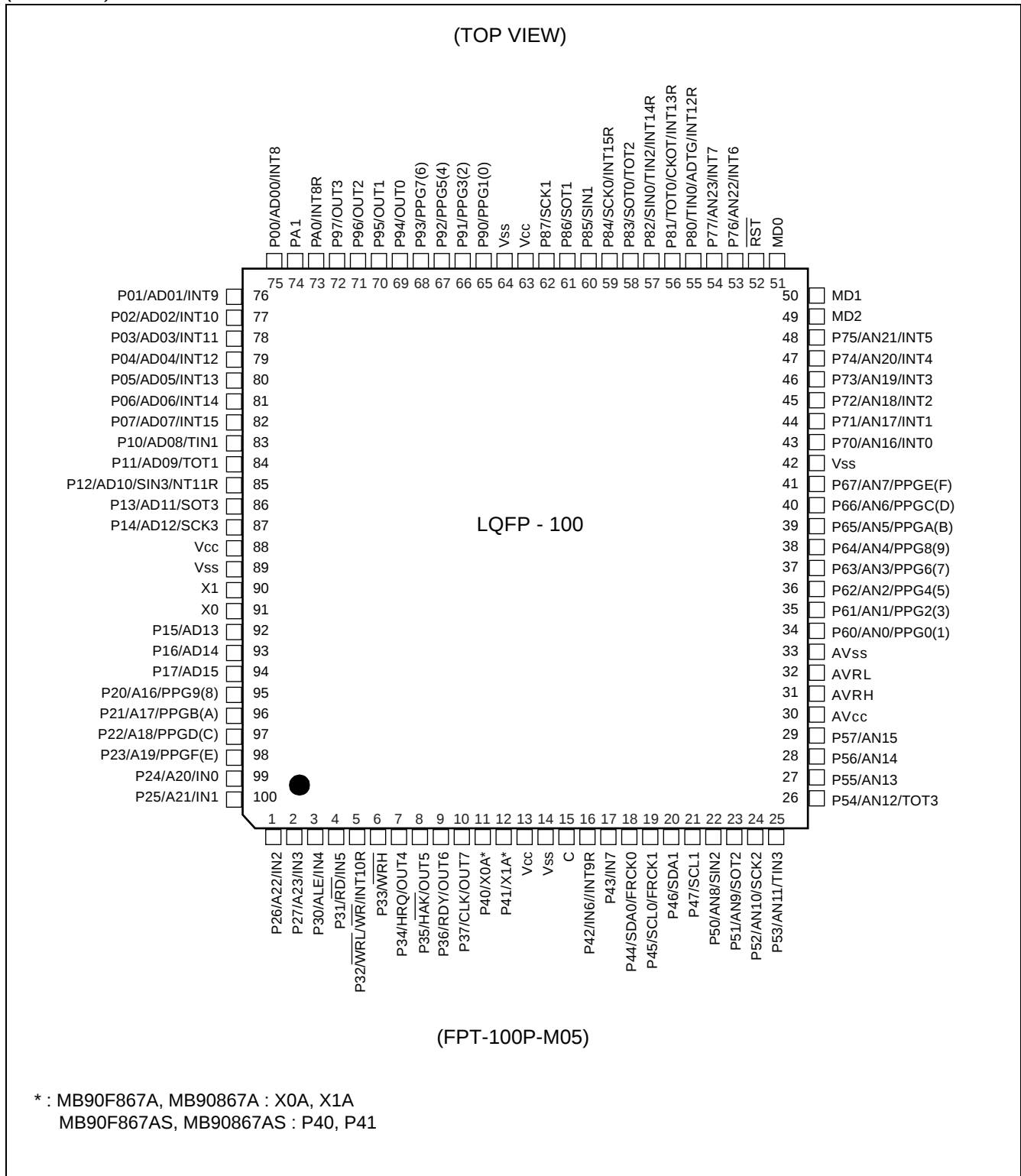
MB90860A Series

PIN ASSIGNMENTS

- MB90F867A (S) , MB90867A (S)



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MB90860A Series

■ PIN DESCRIPTION

Pin No.		Pin name	Circuit type	Function
LQFP100*2	QFP100*1			
90	92	X1	A	Oscillation output
91	93	X0		Oscillation input
52	54	$\overline{\text{RST}}$	E	Reset input
75 to 82	77 to 84	P00 to P07	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
		INT8 to INT15		External interrupt request input pins for INT8 to INT15.
83	85	P10	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD08		I/O pin for bit 8 of the external address/data bus. This function is enabled when the external bus is enabled.
		TIN1		Event input pin for the reload timer 1
84	86	P11	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD09		I/O pin for bit 9 of the external address/data bus. This function is enabled when the external bus is enabled.
		TOT1		Output pin for the reload timer 1
85	87	P12	N	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD10		I/O pin for bit 10 of the external address/data bus. This function is enabled when the external bus is enabled.
		SIN3		Serial data input pin for UART3
		INT11R		Sub external interrupt request input pin for INT11
86	88	P13	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD11		I/O pin for bit 11 of the external address/data bus. This function is enabled when the external bus is enabled.
		SOT3		Serial data output pin for UART3
87	89	P14	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD12		I/O pin for bit 12 of the external address/data bus. This function is enabled when the external bus is enabled.
		SCK3		Clock I/O pin for UART3

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MB90860A Series

Pin No.		Pin name	Circuit type	Function
LQFP100*2	QFP100*1			
92	94	P15	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD13		I/O pin for bit 13 of the external address/data bus. This function is enabled when the external bus is enabled.
		SIN4		Serial data input pin for UART4 (MB90V340 only)
93	95	P16	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD14		I/O pin for bit 14 of the external address/data bus. This function is enabled when the external bus is enabled.
		SOT4		Serial data output pin for UART4 (MB90V340 only)
94	96	P17	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD15		I/O pin for bit 15 of the external address/data bus. This function is enabled when the external bus is enabled.
		SCK4		Clock I/O pin for UART4 (MB90V340 only)
95 to 98	97 to 100	P20 to P23	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. In external bus mode, the pin is enabled as a general-purpose I/O port when the corresponding bit in the external address output control register (HACR) is 1.
		A16 to A19		Output pins for A16 to A19 of the external address bus. When the corresponding bit in the external address output control register (HACR) is 0, the pins are enabled as high address output pins (A16 to A19).
		PPG9,PPGB,PPGD,PPGF		Output pins for PPGs
99 to 2	1 to 4	P24 to P27	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. In external bus mode, the pin is enabled as a general-purpose I/O port when the corresponding bit in the external address output control register (HACR) is 1.
		A20 to A23		Output pins for A20 to A23 of the external address bus. When the corresponding bit in the external address output control register (HACR) is 0, the pins are enabled as high address output pins (A20 to A23).
		IN0 to IN3		Data sample input pins for input captures ICU0 to ICU3
3	5	P30	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		ALE		Address latch enable output pin. This function is enabled when the external bus is enabled.
		IN4		Data sample input pin for input capture ICU4

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MB90860A Series

Pin No.		Pin name	Circuit type	Function
LQFP100*2	QFP100*1			
4	6	P31	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		$\overline{RD}$		Read strobe output pin for the data bus. This function is enabled when the external bus is enabled.
		IN5		Data sample input pin for input capture ICU5
5	7	P32	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or with the $\overline{WR}/\overline{WRL}$ pin output disabled.
		$\overline{WRL} / \overline{WR}$		Write strobe output pin for the data bus. This function is enabled when both the external bus and the $\overline{WR}/\overline{WRL}$ pin output are enabled. $\overline{WRL}$ is used to write-strobe 8 lower bits of the data bus in 16-bit access while $\overline{WR}$ is used to write-strobe 8 bits of the data bus in 8-bit access.
		RX2		RX input pin for CAN2 Interface (MB90V340 only)
		INT10R		Sub external interrupt request input pin for INT10
6	8	P33	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or with the $\overline{WRH}$ pin output disabled.
		$\overline{WRH}$		Write strobe output pin for the 8 higher bits of the data bus. This function is enabled when the external bus is enabled, when the external bus 16-bit mode is selected, and when the $\overline{WRH}$ output pin is enabled.
		TX2		TX Output pin for CAN2 (MB90V340 only)
7	9	P34	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or with the hold function disabled.
		HRQ		Hold request input pin. This function is enabled when both the external bus and the hold function are enabled.
		OUT4		Waveform output pin for output compare OCU4
8	10	P35	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or with the hold function disabled.
		$\overline{HAK}$		Hold acknowledge output pin. This function is enabled when both the external bus and the hold function are enabled.
		OUT5		Waveform output pin for output compare OCU5
9	11	P36	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or with the external ready function disabled.
		RDY		Ready input pin. This function is enabled when both the external bus and the external ready function are enabled.
		OUT6		Waveform output pin for output compare OCU6

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MB90860A Series

Pin No.		Pin name	Circuit type	Function
LQFP100*2	QFP100*1			
10	12	P37	G	General purpose I/O. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or with the CLK output disabled.
		CLK		CLK output pin. This function is enabled when both the external bus and CLK output are enabled.
		OUT7		Waveform output pin for output compare OCU7
11 to 12	13 to 14	P40 , P41	F	General purpose I/O (devices with S-suffix)
		X0A , X1A	B	Oscillator input pins for sub-clock (devices without S-suffix)
16	18	P42	F	General purpose I/O
		IN6		Data sample input pin for input capture ICU6
		RX1		RX input pin for CAN1 (MB90V340 (S) only)
		INT9R		Sub external interrupt request input pin for INT10
17	19	P43	F	General purpose I/O
		IN7		Data sample input pin for input capture ICU7
		TX1		TX Output pin for CAN1 (MB90V340 (S) only)
18	20	P44	H	General purpose I/O
		SDA0		Serial data I/O pin for I ² C 0
		FRCK0		Input for the 16-bit I/O Timer 0
19	21	P45	H	General purpose I/O
		SCL0		Serial clock I/O pin for I ² C 0
		FRCK1		Input for the 16-bit I/O Timer 1
20	22	P46	H	General purpose I/O
		SDA1		Serial data I/O pin for I ² C 1
21	23	P47	H	General purpose I/O
		SCL1		Serial clock I/O pin for I ² C 1
22	24	P50	O	General purpose I/O
		AN8		Analog input pin for the A/D converter
		SIN2		Serial data input pin for UART2
23	25	P51	I	General purpose I/O
		AN9		Analog input pin for the A/D converter
		SOT2		Serial data output pin for UART2
24	26	P52	I	General purpose I/O
		AN10		Analog input pin for the A/D converter
		SCK2		Clock I/O pin for UART2
25	27	P53	I	General purpose I/O
		AN11		Analog input pin for the A/D converter
		TIN3		Event input pin for the reload timer 3

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MB90860A Series

Pin No.		Pin name	Circuit type	Function
LQFP100*2	QFP100*1			
26	28	P54	I	General purpose I/O
		AN12		Analog input pin for the A/D converter
		TOT3		Output pin for the reload timer 3
27	29	P55	I	General purpose I/O
		AN13		Analog input pin for the A/D converter
28, 29	30, 31	P56 to P57	J	General purpose I/O
		AN14 to AN15		Analog input pin for the A/D converter
		DA00 to DA01		D/A converter analog output pins (MB90V340 only)
34 to 41	36 to 43	P60 to P67	I	General purpose I/O
		AN0 to AN7		Analog input pins for the A/D converter
		PPG0, 2, 4, 6, 8, A, C, E		Output pins for PPGs
43 to 48, 53, 54	45 to 50, 55, 56	P70 to P77	I	General purpose I/O
		AN16 to AN23		Analog input pins for the A/D converter (devices with C-suffix)
		INT0 to INT7		External interrupt request input pins for INT0 to INT7
55	57	P80	F	General purpose I/O
		TIN0		Event input pin for the reload timers 0
		ADTG		Trigger input pin for the A/D converter
		INT12R		Sub external interrupt request input pin for INT12
56	58	P81	F	General purpose I/O
		TOT0		Output pin for the reload timer 0
		CKOT		Output pin for the clock monitor
		INT13R		Sub external interrupt request input pin for INT13
57	59	P82	M	General purpose I/O
		SIN0		Serial data input pin for UART0
		TIN2		Event input pin for the reload timers 2
		INT14R		Sub external interrupt request input pin for INT14
58	60	P83	F	General purpose I/O
		SOT0		Serial data output pin for UART0
		TOT2		Output pin for the reload timer 2
59	61	P84	F	General purpose I/O
		SCK0		Clock I/O pin for UART0
		INT15R		Sub external interrupt request input pin for INT15
60	62	P85	M	General purpose I/O
		SIN1		Serial data input pin for UART1
61	63	P86	F	General purpose I/O
		SOT1		Serial data output pin for UART1

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MB90860A Series

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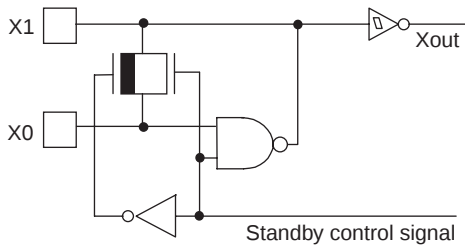
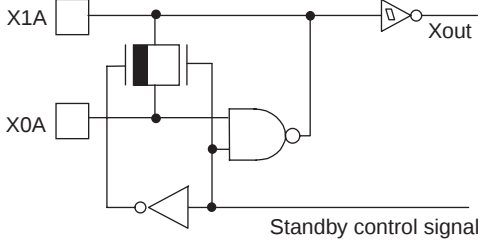
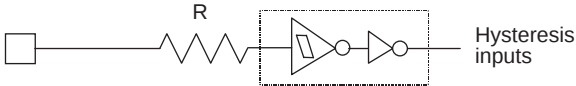
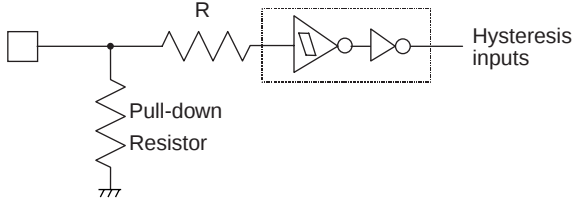
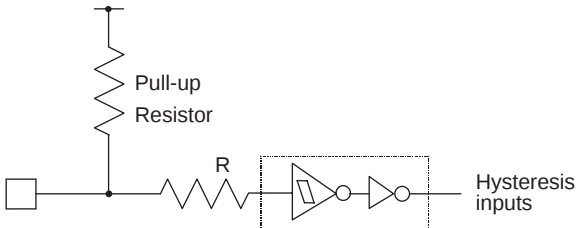
Pin No.		Pin name	Circuit type	Function
LQFP100*2	QFP100*1			
62	64	P87	F	General purpose I/O
		SCK1		Clock I/O pin for UART1
65 to 68	67 to 70	P90 to P93	F	General purpose I/O
		PPG1, 3, 5, 7		Output pins for PPGs
69 to 72	71 to 74	P94 to P97	F	General purpose I/O
		OUT0 to OUT3		Waveform output pins for output compares OCU0 to OCU3. This function is enabled when the OCU enables waveform output.
73	75	PA0	F	General purpose I/O
		RX0		RX input pin for CAN0 (MB90V340 (s) only)
		INT8R		Sub external interrupt request input pin for INT8
74	76	PA1	F	General purpose I/O
		TX0		TX Output pin for CAN0 (MB90V340 (s) only)
30	32	AV _{CC}	K	V _{CC} power input pin for analog circuits
31	33	AVRH	L	Reference voltage input for the A/D Converter. This power supply must be turned on or off while a voltage higher than or equal to AVRH is applied to AV _{CC} .
32	34	AVRL	K	Lower reference voltage input for the A/D Converter
33	35	AV _{SS}	K	V _{SS} power input pin for analog circuits
50, 51	52, 53	MD1, MD0	C	Input pins for specifying the operating mode. The pins must be directly connected to V _{CC} or V _{SS}
49	51	MD2	D	Input pin for specifying the operating mode. The pins must be directly connected to V _{CC} or V _{SS} .
13 63 88	15 65 90	V _{CC}	—	Power (3.5 V to 5.5 V) input pins
14 42 64 89	16 44 66 91	V _{SS}	—	Power (0V) input pins
15	17	C	K	This is the power supply stabilization capacitor pin. It should be connected to a higher than or equal to 0.1 μF ceramic capacitor.

*1 : FPT-100P-M06

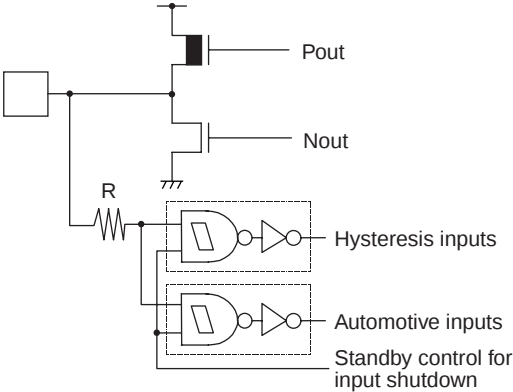
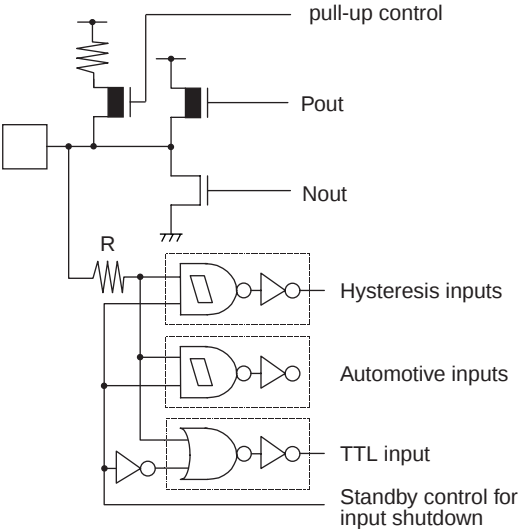
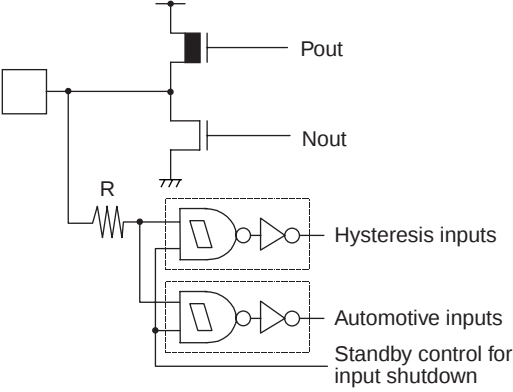
*2 : FPT-100P-M05

MB90860A Series

■ I/O CIRCUIT TYPE

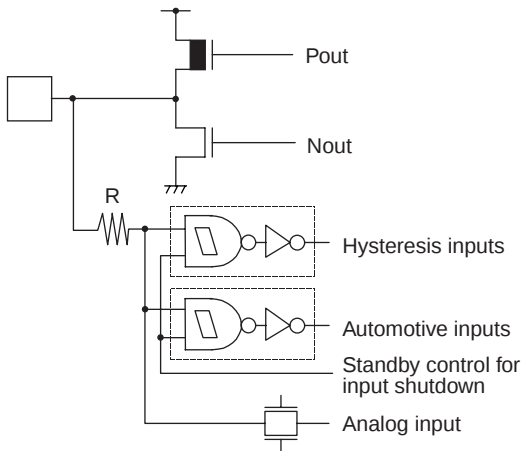
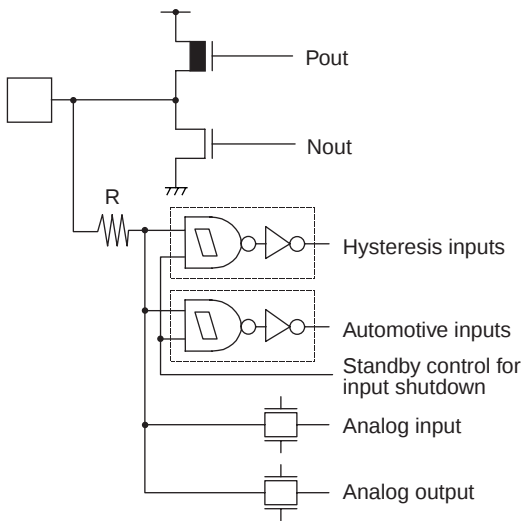
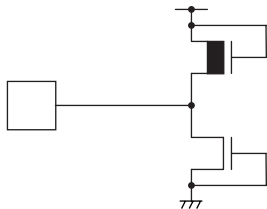
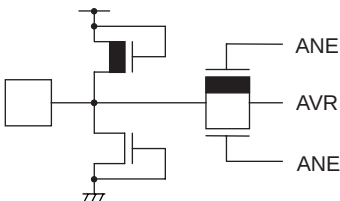
Type	Circuit	Remarks
A		Oscillation circuit • High-speed oscillation feedback resistor = approx. 1 MΩ
B		Oscillation circuit • Low-speed oscillation feedback resistor = approx. 10 MΩ
C		Mask ROM and EVA device: • CMOS Hysteresis input pin Flash device: • CMOS input pin
D		Mask ROM and EVA device: • CMOS Hysteresis input pin • Pull-down resistor value: approx. 50 kΩ Flash device: • CMOS input pin • No Pull-down
E		CMOS Hysteresis input pin • Pull-up resistor value: approx. 50 kΩ

(Continued)

Type	Circuit	Remarks
F		• CMOS level output($I_{OL} = 4\text{ mA}$, $I_{OH} = -4\text{ mA}$) • CMOS hysteresis inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function)
G		• CMOS level output($I_{OL} = 4\text{ mA}$, $I_{OH} = -4\text{ mA}$) • CMOS hysteresis inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function) • TTL input (With the standby-time input shutdown function) • Programmable pullup resistor: $50\text{ k}\Omega$ approx.
H		• CMOS level output($I_{OL} = 3\text{ mA}$, $I_{OH} = -3\text{ mA}$) • CMOS hysteresis inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function)

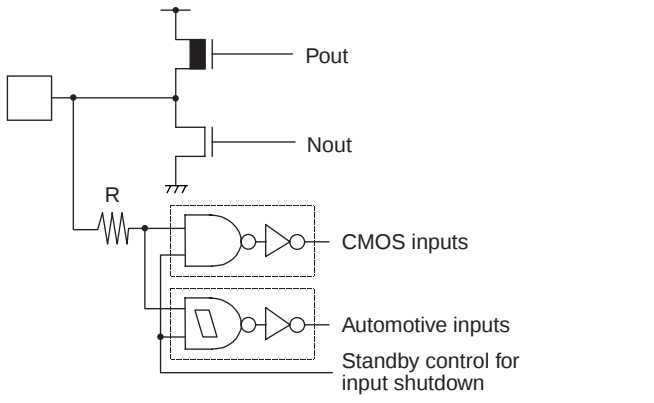
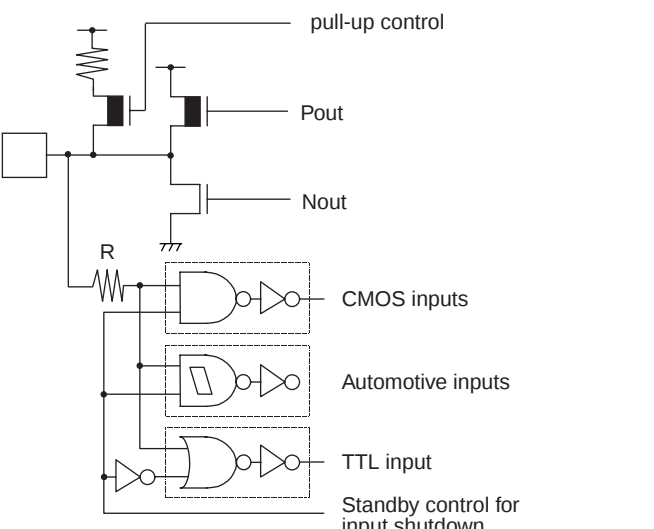
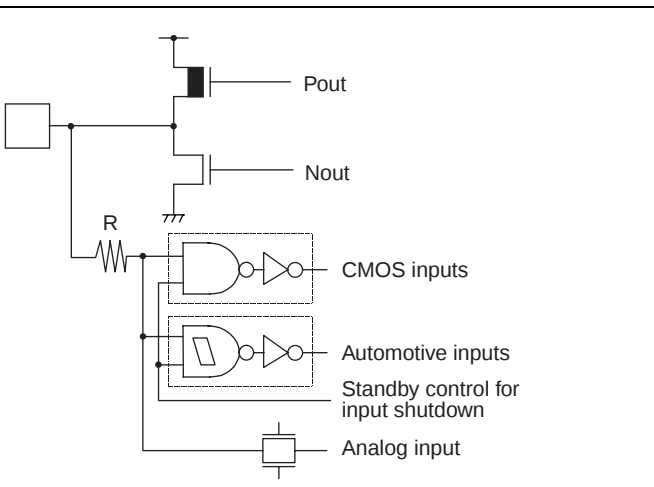
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MB90860A Series

Type	Circuit	Remarks
I		• CMOS level output($I_{OL} = 4\text{ mA}$, $I_{OH} = -4\text{ mA}$) • CMOS hysteresis inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function) • A/D analog input
J		• CMOS level output($I_{OL} = 4\text{ mA}$, $I_{OH} = -4\text{ mA}$) • D/A analog output • CMOS hysteresis inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function) • A/D analog input
K		• Power supply input protection circuit
L		• A/D converter reference voltage power supply input pin, with the protection circuit • Flash devices do not have a protection circuit against V_{CC} for pin AVRH

(Continued)

(Continued)

Type	Circuit	Remarks
M		• CMOS level output($I_{OL} = 4\text{ mA}$, $I_{OH} = -4\text{ mA}$) • CMOS inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function)
N		• CMOS level output($I_{OL} = 4\text{ mA}$, $I_{OH} = -4\text{ mA}$) • CMOS inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function) • TTL input (With the standby-time input shutdown function) Programmable pullup register:50 kΩ approx.
O		• CMOS level output($I_{OL} = 4\text{ mA}$, $I_{OH} = -4\text{ mA}$) • CMOS inputs (With the standby-time input shutdown function) • Automotive input (With the standby-time input shutdown function) • A/D analog input

MB90860A Series

■ HANDLING DEVICES

Special care is required for the following when handling the device :

- Preventing latch-up
- Treatment of unused pins
- Using external clock
- Precautions for when not using a sub clock signal
- Notes on during operation of PLL clock mode
- Power supply pins (V_{CC}/V_{SS})
- Pull-up/down resistors
- Crystal Oscillator Circuit
- Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs
- Connection of Unused Pins of A/D Converter
- Notes on Energization
- Stabilization of power supply voltage
- Initialization
- Port0 to port3 output during Power-on(**External-bus mode**)
- Flash security Function

1. Preventing latch-up

CMOS IC chips may suffer latch-up under the following conditions :

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between V_{CC} and V_{SS} .
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current drastically, causing thermal damage to the device.

For the same reason, also be careful not to let the analog power-supply voltage (AV_{CC} , AV_{RH}) exceed the digital power-supply voltage.

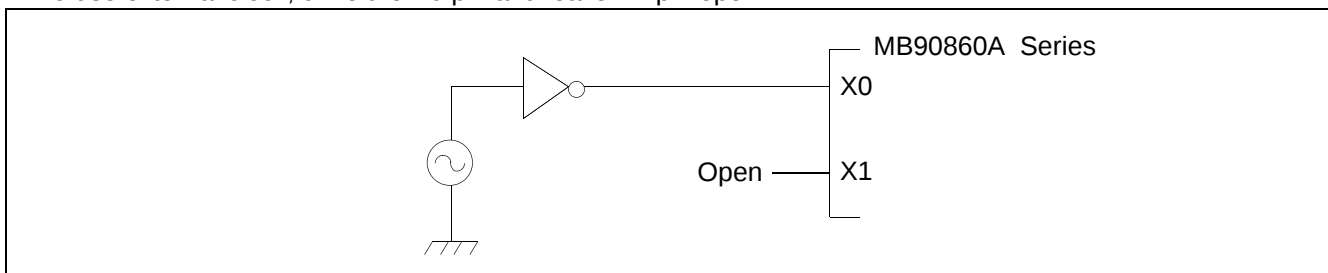
2. Treatment of unused pins

Leaving unused input pins open may result in misbehavior or latch up and possible permanent damage of the device. Therefore they must be pulled up or pulled down through resistors. In this case those resistors should be more than 2 k Ω .

Unused bidirectional pins should be set to the output state and can be left open, or the input state with the above described connection.

3. Using external clock

To use external clock, drive the X0 pin and leave X1 pin open.



4. Precautions for when not using a sub clock signal

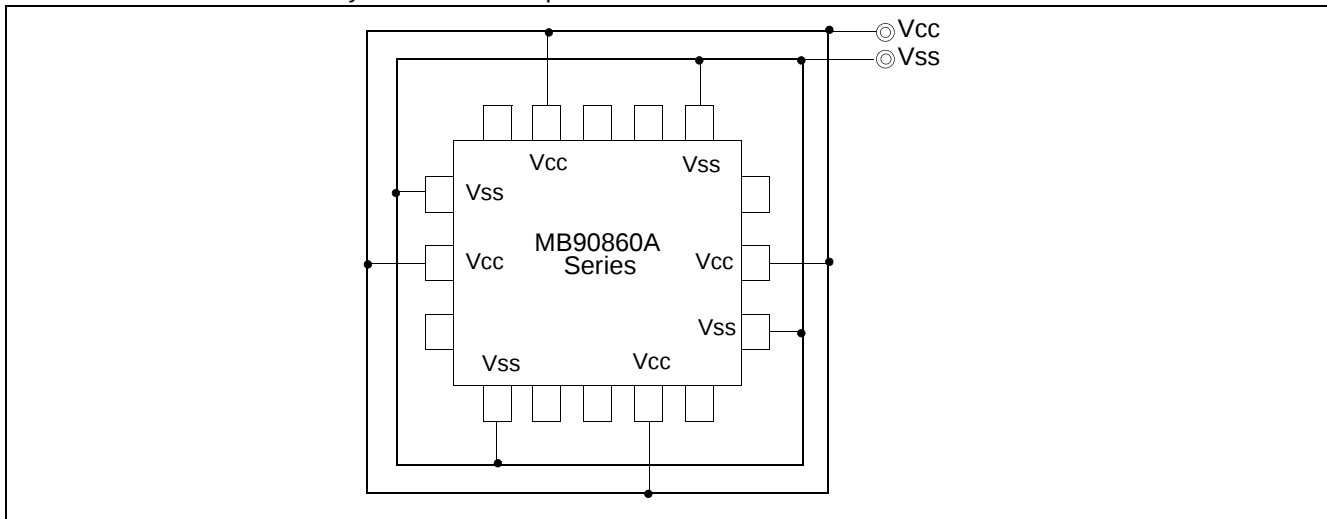
If you do not connect pins X0A and X1A to an oscillator, use pull-down handling on the X0A pin, and leave the X1A pin open.

5. Notes on during operation of PLL clock mode

If the PLL clock mode is selected, the microcontroller attempt to be working with the self-oscillating circuit even when there is no external oscillator or external clock input is stopped. Performance of this operation, however, cannot be guaranteed.

6. Power supply pins (V_{CC}/V_{SS})

- If there are multiple V_{CC} and V_{SS} pins, from the point of view of device design, pins to be of the same potential are connected the inside of the device to prevent such malfunctioning as latch up.
To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the V_{CC} and V_{SS} pins to the power supply and ground externally.
- Connect V_{CC} and V_{SS} to the device from the current supply source at a low impedance.
- As a measure against power supply noise, connect a capacitor of about 0.1 μF as a bypass capacitor between V_{CC} and V_{SS} in the vicinity of V_{CC} and V_{SS} pins of the device



7. Pull-up/down resistors

The MB90860A Series does not support internal pull-up/down resistors (Port 0 to Port 3: built-in pull-up resistors). Use external components where needed.

8. Crystal Oscillator Circuit

Noises around X0 or X1 pins may be possible causes of abnormal operations. Make sure to provide bypass capacitors via shortest distance from X0, X1 pins, crystal oscillator (or ceramic resonator) and ground lines, and make sure, to the utmost effort, that lines of oscillation circuit not cross the lines of other circuits.

It is highly recommended to provide a printed circuit board art work surrounding X0 and X1 pins with a ground area for stabilizing the operation.

9. Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs

Make sure to turn on the A/D converter power supply (AV_{CC} , AV_{RH} , AV_{RL}) and analog inputs ($AN0$ to $AN23$) after turning-on the digital power supply (V_{CC}).

Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage not exceed AV_{RH} or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

10. Connection of Unused Pins of A/D Converter if A/D Converter is used

Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AV_{RH} = AV_{RL} = V_{SS}$.

MB90860A Series

11. Notes on Energization

To prevent the internal regulator circuit from malfunctioning, set the voltage rise time during energization at 50 μ s or more (0.2 V to 2.7 V)

12. Stabilization of power supply voltage

A sudden change in the supply voltage may cause the device to malfunction even within the specified V_{CC} supply voltage operating range. Therefore, the V_{CC} supply voltage should be stabilized.

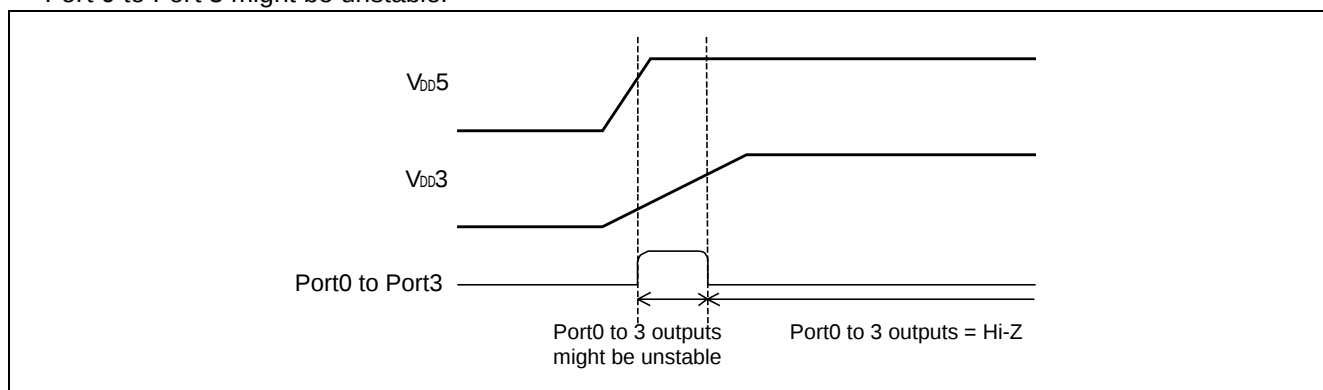
For reference, the supply voltage should be controlled so that V_{CC} ripple variations (peak-to-peak value) at commercial frequencies (50 Hz to 60 Hz) fall below 10% of the standard V_{CC} supply voltage and the coefficient of fluctuation does not exceed 0.1 V/ms at instantaneous power switching.

13. Initialization

In the device, there are internal registers which are initialized only by a power-on reset. To initialize these registers, turn on the power again.

14. Port 0 to port 3 output during Power-on (External-bus mode)

As shown below, when power is turned on in External-Bus mode, there is a possibility that output signal of Port 0 to Port 3 might be unstable.



15. Flash security Function

The security byte is located in the area of the flash memory.

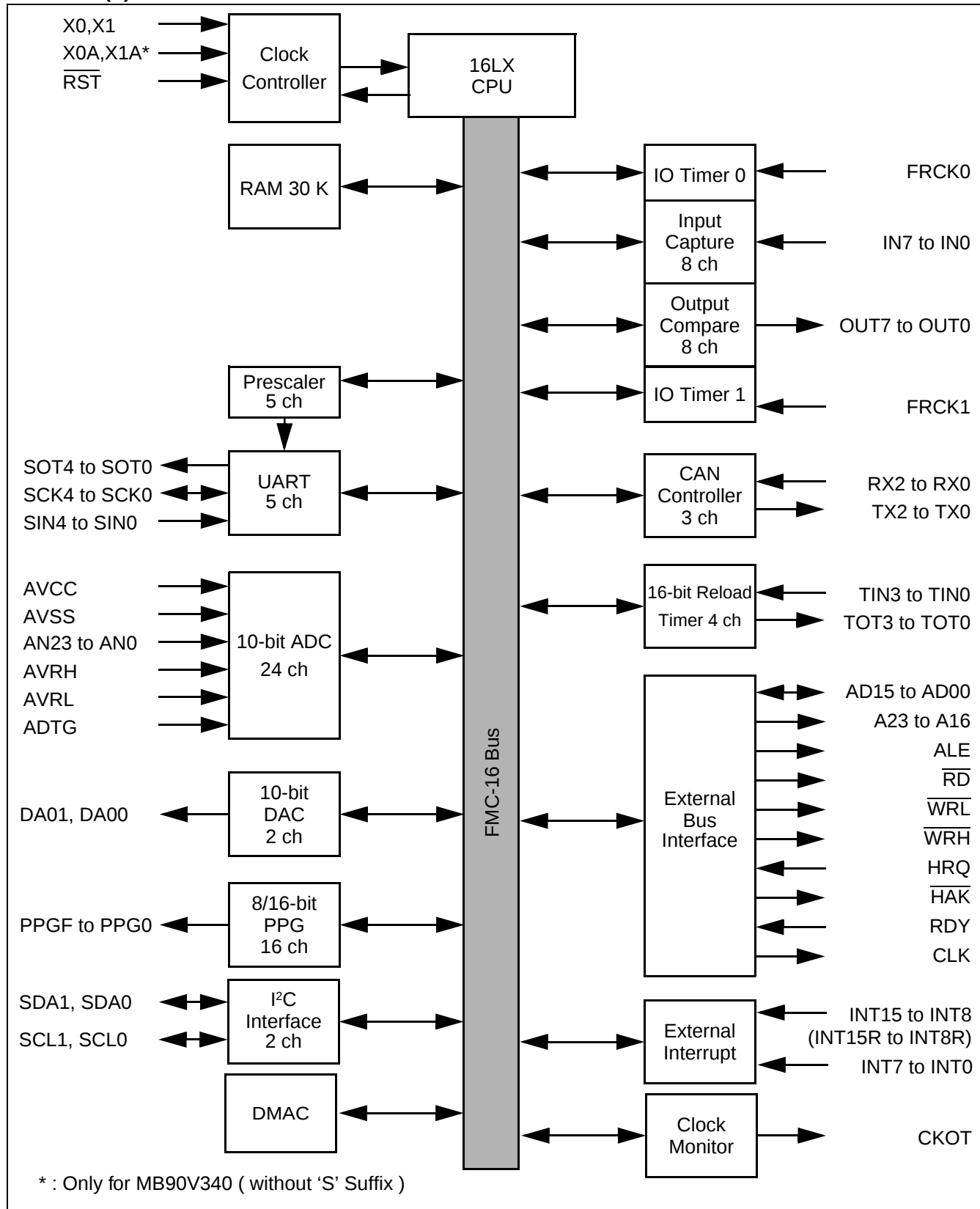
If protection code 01_H is written in the security byte, the flash memory is in the protected state by security. Therefore please do not write 01_H in this address if you do not use the security function.

Please refer to following table for the address of the security byte.

	Flash memory size	Address for security byte
MB90F867A (S)	Embedded 1 Mbit Flash Memory	FE0001 _H

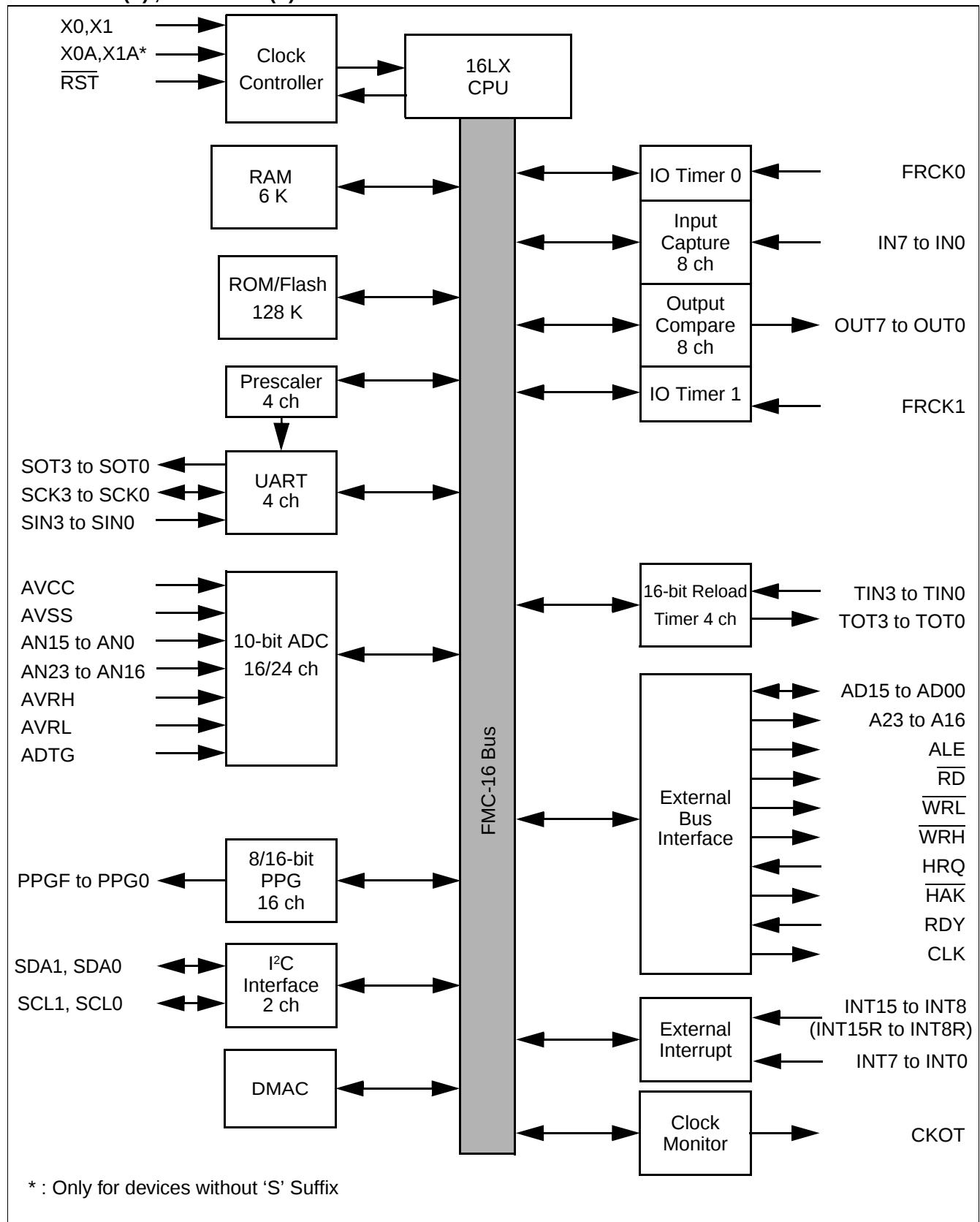
■ BLOCK DIAGRAMS

MB90V340(S)

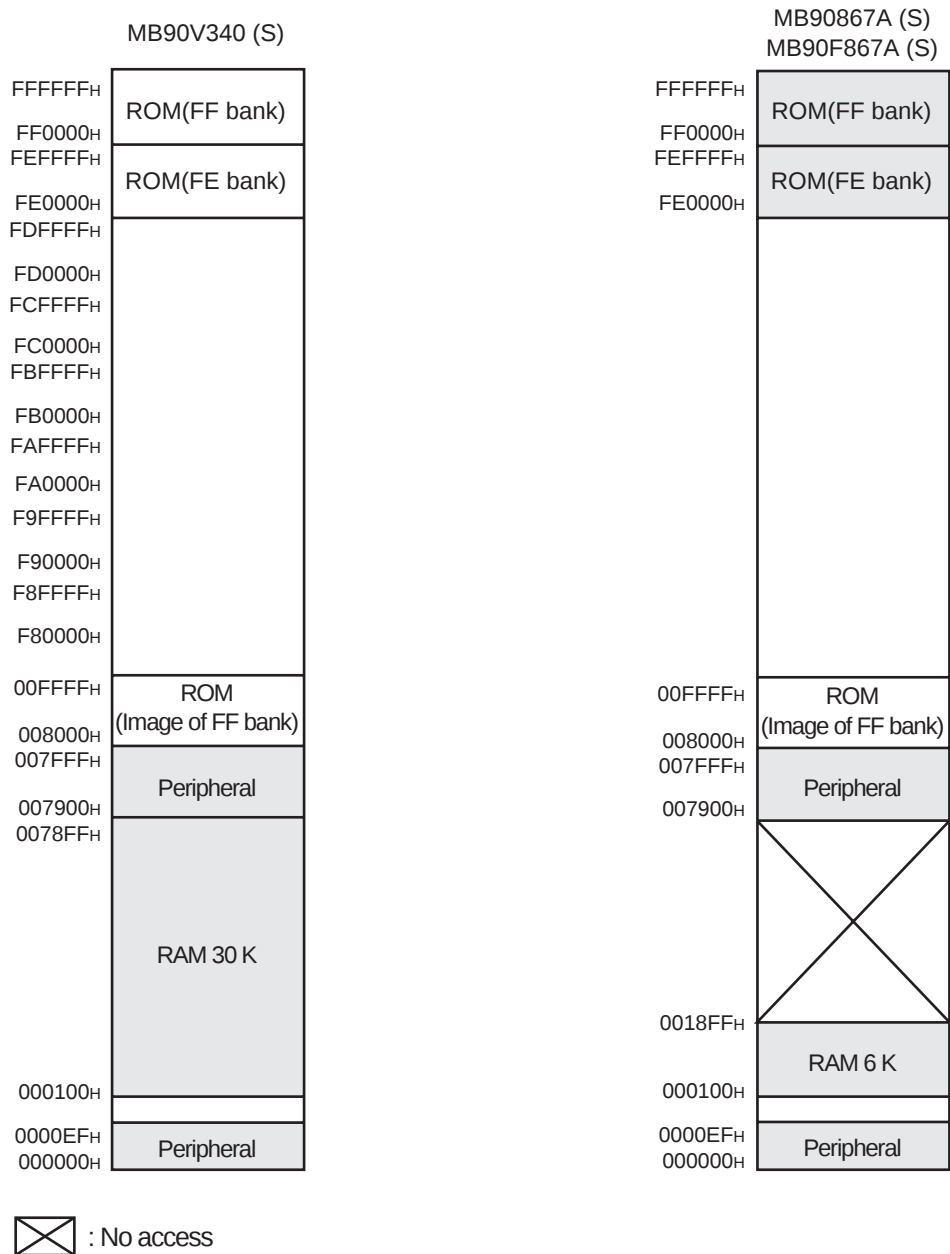


MB90860A Series

MB90F867A (S) , MB90867A (S)



■ MEMORY MAP



Note : The high-order portion of bank 00 gives the image of the FF bank ROM to make the small model of the C compiler effective. Since the low-order 16 bits are the same, the table in ROM can be referenced without using the far specification in the pointer declaration.

For example, an attempt to access 00C00_H accesses the value at FFC00_H in ROM.

The ROM area in bank FF exceeds 32 Kbytes, and its entire image cannot be shown in bank 00.

The image between FF800_H and FFFFF_H is visible in bank 00, while the image between FF000_H and FF7FFF_H is visible only in bank FF.

MB90860A Series

■ I/O MAP

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
00 _H	Port 0 Data Register	PDR0	R/W	Port 0	XXXXXXXX
01 _H	Port 1 Data Register	PDR1	R/W	Port 1	XXXXXXXX
02 _H	Port 2 Data Register	PDR2	R/W	Port 2	XXXXXXXX
03 _H	Port 3 Data Register	PDR3	R/W	Port 3	XXXXXXXX
04 _H	Port 4 Data Register	PDR4	R/W	Port 4	XXXXXXXX
05 _H	Port 5 Data Register	PDR5	R/W	Port 5	XXXXXXXX
06 _H	Port 6 Data Register	PDR6	R/W	Port 6	XXXXXXXX
07 _H	Port 7 Data Register	PDR7	R/W	Port 7	XXXXXXXX
08 _H	Port 8 Data Register	PDR8	R/W	Port 8	XXXXXXXX
09 _H	Port 9 Data Register	PDR9	R/W	Port 9	XXXXXXXX
0A _H	Port A Data Register	PDRA	R/W	Port A	XXXXXXXX
0B _H	Port 5 Analog Input Enable Register	ADER5	R/W	Port 5, A/D	11111111
0C _H	Port 6 Analog Input Enable Register	ADER6	R/W	Port 6, A/D	11111111
0D _H	Port 7 Analog Input Enable Register	ADER7	R/W	Port 7, A/D	11111111
0E _H	Input Level Select Register 0	ILSR0	R/W	Ports	00000000
0F _H	Input Level Select Register 1	ILSR1	R/W	Ports	00000000
10 _H	Port 0 Direction Register	DDR0	R/W	Port 0	00000000
11 _H	Port 1 Direction Register	DDR1	R/W	Port 1	00000000
12 _H	Port 2 Direction Register	DDR2	R/W	Port 2	00000000
13 _H	Port 3 Direction Register	DDR3	R/W	Port 3	00000000
14 _H	Port 4 Direction Register	DDR4	R/W	Port 4	00000000
15 _H	Port 5 Direction Register	DDR5	R/W	Port 5	00000000
16 _H	Port 6 Direction Register	DDR6	R/W	Port 6	00000000
17 _H	Port 7 Direction Register	DDR7	R/W	Port 7	00000000
18 _H	Port 8 Direction Register	DDR8	R/W	Port 8	00000000
19 _H	Port 9 Direction Register	DDR9	R/W	Port 9	00000000
1A _H	Port A Direction Register	DDRA	R/W	Port A	00000100
1B _H	Reserved				
1C _H	Port 0 Pullup Control Register	PUCR0	R/W	Port 0	00000000
1D _H	Port 1 Pullup Control Register	PUCR1	R/W	Port 1	00000000
1E _H	Port 2 Pullup Control Register	PUCR2	R/W	Port 2	00000000
1F _H	Port 3 Pullup Control Register	PUCR3	R/W	Port 3	00000000

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
20 _H	Serial Mode Register 0	SMR0	W, R/W	UART0	00000000
21 _H	Serial Control Register 0	SCR0	W, R/W		00000000
22 _H	Reception/Transmission Data Register 0	RDR0/ TDR0	R/W		00000000
23 _H	Serial Status Register 0	SSR0	R, R/W		00001000
24 _H	Extended Communication Control Reg. 0	ECCR0	R, W, R/W		000000XX
25 _H	Extended Status/Control Register 0	ESCR0	R/W		00000100
26 _H	Baud Rate Generator Register 00	BGR00	R/W		00000000
27 _H	Baud Rate Generator Register 01	BGR01	R/W		00000000
28 _H	Serial Mode Register 1	SMR1	W, R/W	UART1	00000000
29 _H	Serial Control Register 1	SCR1	W, R/W		00000000
2A _H	Reception/Transmission Data Register 1	RDR1/ TDR1	R/W		00000000
2B _H	Serial Status Register 1	SSR1	R, R/W		00001000
2C _H	Extended Communication Control Reg. 1	ECCR1	R, W, R/W		000000XX
2D _H	Extended Status Control Register 1	ESCR1	R/W		00000100
2E _H	Baud Rate Generator Register 10	BGR10	R/W		00000000
2F _H	Baud Rate Generator Register 11	BGR11	R/W		00000000
30 _H	PPG 0 Operation Mode Control Register	PPGC0	W, R/W	16-bit PPG 0/1	0X000XX1
31 _H	PPG 1 Operation Mode Control Register	PPGC1	W, R/W		0X000001
32 _H	PPG 01 Clock Select Register	PPG01	R/W		000000X0
33 _H	Reserved				
34 _H	PPG 2 Operation Mode Control Register	PPGC2	W, R/W	16-bit PPG 2/3	0X000XX1
35 _H	PPG 3 Operation Mode Control Register	PPGC3	W, R/W		0X000001
36 _H	PPG 23 Clock Select Register	PPG23	R/W		000000X0
37 _H	Reserved				
38 _H	PPG 4 Operation Mode Control Register	PPGC4	W, R/W	16-bit PPG 4/5	0X000XX1
39 _H	PPG 5 Operation Mode Control Register	PPGC5	W, R/W		0X000001
3A _H	PPG 4 and PPG 5 Clock Select Register	PPG45	R/W		000000X0
3B _H	Program Address Detection Control Status Register 1	PACSR1	R/W	Address Match Detection 1	00000000
3C _H	PPG 6 Operation Mode Control Register	PPGC6	W, R/W	16-bit PPG 6/7	0X000XX1
3D _H	PPG 7 Operation Mode Control Register	PPGC7	W, R/W		0X000001
3E _H	PPG 67 Clock Select Register	PPG67	R/W		000000X0
3F _H	Reserved				

(Continued)

MB90860A Series

Address	Register	Abbrevi- ation	Access	Resource name	Initial value
40 _H	PPG 8 Operation Mode Control Register	PPGC8	W, R/W	16-bit PPG 8/9	0X000XX1
41 _H	PPG 9 Operation Mode Control Register	PPGC9	W, R/W		0X000001
42 _H	PPG 89 Clock Select Register	PPG89	R/W		000000X0
43 _H	Reserved				
44 _H	PPG A Operation Mode Control Register	PPGCA	W, R/W	16-bit PPG A/B	0X000XX1
45 _H	PPG B Operation Mode Control Register	PPGCB	W, R/W		0X000001
46 _H	PPG AB Clock Select Register	PPGAB	R/W		000000X0
47 _H	Reserved				
48 _H	PPG C Operation Mode Control Register	PPGCC	W, R/W	16-bit PPG C/D	0X000XX1
49 _H	PPG D Operation Mode Control Register	PPGCD	W, R/W		0X000001
4A _H	PPG CD Clock Select Register	PPGCD	R/W		000000X0
4B _H	Reserved				
4C _H	PPG E Operation Mode Control Register	PPGCE	W, R/W	16-bit PPG E/F	0X000XX1
4D _H	PPG F Operation Mode Control Register	PPGCF	W, R/W		0X000001
4E _H	PPG EF Clock Select Register	PPGEF	R/W		000000X0
4F _H	Reserved				
50 _H	Input Capture Control Status Register 0/1	ICS01	R/W	Input Capture 0/1	00000000
51 _H	Input Capture Edge Register 0/1	ICE01	R/W, R		XXX0X0XX
52 _H	Input Capture Control Status Register 2/3	ICS23	R/W	Input Capture 2/3	00000000
53 _H	Input Capture Edge Register 2/3	ICE23	R		XXXXXXXXXX
54 _H	Input Capture Control Status Register 4/5	ICS45	R/W	Input Capture 4/5	00000000
55 _H	Input Capture Edge Register 4/5	ICE45	R		XXXXXXXXXX
56 _H	Input Capture Control Status Register 6/7	ICS67	R/W	Input Capture 6/7	00000000
57 _H	Input Capture Edge Register 6/7	ICE67	R/W, R		XXX000XX
58 _H	Output Compare Control Status Register 0	OCS0	R/W	Output Compare 0/1	0000XX00
59 _H	Output Compare Control Status Register 1	OCS1	R/W		0XX00000
5A _H	Output Compare Control Status Register 2	OCS2	R/W	Output Compare 2/3	0000XX00
5B _H	Output Compare Control Status Register 3	OCS3	R/W		0XX00000
5C _H	Output Compare Control Status Register 4	OCS4	R/W	Output Compare 4/5	0000XX00
5D _H	Output Compare Control Status Register 5	OCS5	R/W		0XX00000
5E _H	Output Compare Control Status Register 6	OCS6	R/W	Output Compare 6/7	0000XX00
5F _H	Output Compare Control Status Register 7	OCS7	R/W		0XX00000

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
60 _H	Timer Control Status Register 0	TMCSR0	R/W	16-bit Reload Timer 0	00000000
61 _H	Timer Control Status Register 0	TMCSR0	R/W		XXXX0000
62 _H	Timer Control Status Register 1	TMCSR1	R/W	16-bit Reload Timer 1	00000000
63 _H	Timer Control Status Register 1	TMCSR1	R/W		XXXX0000
64 _H	Timer Control Status Register 2	TMCSR2	R/W	16-bit Reload Timer 2	00000000
65 _H	Timer Control Status Register 2	TMCSR2	R/W		XXXX0000
66 _H	Timer Control Status Register 3	TMCSR3	R/W	16-bit Reload Timer 3	00000000
67 _H	Timer Control Status Register 3	TMCSR3	R/W		XXXX0000
68 _H	A/D Control Status Register 0	ADCS0	R/W	A/D Converter	000XXXX0
69 _H	A/D Control Status Register 1	ADCS1	R/W		0000000X
6A _H	A/D Data Register 0	ADCR0	R		00000000
6B _H	A/D Data Register 1	ADCR1	R		XXXXXXXX00
6C _H	ADC Setting Register 0	ADSR0	R/W		00000000
6D _H	ADC Setting Register 1	ADSR1	R/W		00000000
6E _H	Reserved				
6F _H	ROM Mirroring Register	ROMM	W	ROM Mirror	XXXXXXXX1
70 _H to 8F _H	Reserved				
90 _H to 9A _H	Reserved				
9B _H	DMA Descriptor Channel Specification Register	DCSR	R/W	DMA	00000000
9C _H	DMA Status Register L	DSRL	R/W		00000000
9D _H	DMA Status Register H	DSRH	R/W		00000000
9E _H	Program Address Detection Control Status Register 0	PACSR0	R/W	Address Match Detection 0	00000000
9F _H	Delayed Interrupt/Release	DIRR	R/W	Delayed Interrupt	XXXXXXXX0
A0 _H	Low-power Mode Control Register	LPMCR	W, R/W	Low Power Controller	00011000
A1 _H	Clock Selection Register	CKSCR	R, R/W	Low Power Controller	11111100
A2 _H , A3 _H	Reserved				
A4 _H	DMA Stop Status Register	DSSR	R/W	DMA	00000000
A5 _H	Automatic Ready Function Select Reg.	ARSR	W	External Memory Access	0011XX00
A6 _H	External Address Output Control Reg.	HACR	W		00000000
A7 _H	Bus Control Signal Selection Register	ECSR	W		0000000X
A8 _H	Watchdog Control Register	WDTC	R, W	Watchdog Timer	XXXXX111
A9 _H	Timebase Timer Control Register	TBTC	W, R/W	Time Base Timer	1XX00100

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
AA _H	Watch Timer Control Register	WTC	R, R/W	Watch Timer	1X001000
AB _H	Reserved				
AC _H	DMA Enable Register L	DERL	R/W	DMA	00000000
AD _H	DMA Enable Register H	DERH	R/W		00000000
AE _H	Flash Control Status Register (FlashDevices only. Otherwise reserved)	FMCS	R, R/W	Flash Memory	000X0000
AF _H	Reserved				
B0 _H	Interrupt Control Register 00	ICR00	W, R/W	Interrupt Controller	00000111
B1 _H	Interrupt Control Register 01	ICR01	W, R/W		00000111
B2 _H	Interrupt Control Register 02	ICR02	W, R/W		00000111
B3 _H	Interrupt Control Register 03	ICR03	W, R/W		00000111
B4 _H	Interrupt Control Register 04	ICR04	W, R/W		00000111
B5 _H	Interrupt Control Register 05	ICR05	W, R/W		00000111
B6 _H	Interrupt Control Register 06	ICR06	W, R/W		00000111
B7 _H	Interrupt Control Register 07	ICR07	W, R/W		00000111
B8 _H	Interrupt Control Register 08	ICR08	W, R/W		00000111
B9 _H	Interrupt Control Register 09	ICR09	W, R/W		00000111
BA _H	Interrupt Control Register 10	ICR10	W, R/W		00000111
BB _H	Interrupt Control Register 11	ICR11	W, R/W		00000111
BC _H	Interrupt Control Register 12	ICR12	W, R/W		00000111
BD _H	Interrupt Control Register 13	ICR13	W, R/W		00000111
BE _H	Interrupt Control Register 14	ICR14	W, R/W		00000111
BF _H	Interrupt Control Register 15	ICR15	W, R/W		00000111
C0 _H	D/A Converter Data 0	DAT0	R/W	D/A Converter	XXXXXXXX
C1 _H	D/A Converter Data 1	DAT1	R/W		XXXXXXXX
C2 _H	D/A Control 0	DACR0	R/W		XXXXXXXX0
C3 _H	D/A Control 1	DACR1	R/W		XXXXXXXX0
C4 _H , C5 _H	Reserved				
C6 _H	External Interrupt Request Enable Register 0	ENIR0	R/W	External Interrupt 0	00000000
C7 _H	External Interrupt Request Register 0	EIRR0	R/W		XXXXXXXX
C8 _H	External Interrupt Level Register 0	ELVR0	R/W		00000000
C9 _H	External Interrupt Level Register 0	ELVR0	R/W		00000000

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
CA _H	External Interrupt Request Enable Register 1	ENIR1	R/W	External Interrupt 1	00000000
CB _H	External Interrupt Request Register 1	EIRR1	R/W		XXXXXXXX
CC _H	External Interrupt Level Register 1	ELVR1	R/W		00000000
CD _H	External Interrupt Level Register 1	ELVR1	R/W		00000000
CE _H	External Interrupt Source Select Register	EISSR	R/W		00000000
CF _H	PLL/Subclock Control Register	PSCCR	W	PLL	XXXX0000
D0 _H	DMA Buffer Address Pointer L	BAPL	R/W	DMA	XXXXXXXX
D1 _H	DMA Buffer Address Pointer M	BAPM	R/W		XXXXXXXX
D2 _H	DMA Buffer Address Pointer H	BAPH	R/W		XXXXXXXX
D3 _H	DMA Control Register	DMACS	R/W		XXXXXXXX
D4 _H	I/O Register Address Pointer L	IOAL	R/W		XXXXXXXX
D5 _H	I/O Register Address Pointer H	IOAH	R/W		XXXXXXXX
D6 _H	Data Counter L	DCTL	R/W		XXXXXXXX
D7 _H	Data Counter H	DCTH	R/W		XXXXXXXX
D8 _H	Serial Mode Register 2	SMR2	W, R/W	UART2	00000000
D9 _H	Serial Control Register 2	SCR2	W, R/W		00000000
DA _H	Reception/Transmission Data Register 2	RDR2/ TDR2	R/W		00000000
DB _H	Serial Status Register 2	SSR2	R, R/W		00001000
DC _H	Extended Communication Control Register 2	ECCR2	R, W, R/W		000000XX
DD _H	Extended Status/Control Register 2	ESCR2	R/W		00000100
DE _H	Baud Rate Reload Register 20	BGR20	R/W		00000000
DF _H	Baud Rate Reload Register 21	BGR21	R/W		00000000
E0 _H to EF _H	Reserved				
F0 _H to FF _H	External				

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
7900 _H	Reload Register L0	PRL0	R/W	16-bit PPG 0/1	XXXXXXXX
7901 _H	Reload Register H0	PRLH0	R/W		XXXXXXXX
7902 _H	Reload Register L1	PRL1	R/W		XXXXXXXX
7903 _H	Reload Register H1	PRLH1	R/W		XXXXXXXX
7904 _H	Reload Register L2	PRL2	R/W	16-bit PPG 2/3	XXXXXXXX
7905 _H	Reload Register H2	PRLH2	R/W		XXXXXXXX
7906 _H	Reload Register L3	PRL3	R/W		XXXXXXXX
7907 _H	Reload Register H3	PRLH3	R/W		XXXXXXXX
7908 _H	Reload Register L4	PRL4	R/W	16-bit PPG 4/5	XXXXXXXX
7909 _H	Reload Register H4	PRLH4	R/W		XXXXXXXX
790A _H	Reload Register L5	PRL5	R/W		XXXXXXXX
790B _H	Reload Register H5	PRLH5	R/W		XXXXXXXX
790C _H	Reload Register L6	PRL6	R/W	16-bit PPG 6/7	XXXXXXXX
790D _H	Reload Register H6	PRLH6	R/W		XXXXXXXX
790E _H	Reload Register L7	PRL7	R/W		XXXXXXXX
790F _H	Reload Register H7	PRLH7	R/W		XXXXXXXX
7910 _H	Reload Register L8	PRL8	R/W	16-bit PPG 8/9	XXXXXXXX
7911 _H	Reload Register H8	PRLH8	R/W		XXXXXXXX
7912 _H	Reload Register L9	PRL9	R/W		XXXXXXXX
7913 _H	Reload Register H9	PRLH9	R/W		XXXXXXXX
7914 _H	Reload Register LA	PRLA	R/W	16-bit PPG A/B	XXXXXXXX
7915 _H	Reload Register HA	PRLHA	R/W		XXXXXXXX
7916 _H	Reload Register LB	PRLB	R/W		XXXXXXXX
7917 _H	Reload Register HB	PRLHB	R/W		XXXXXXXX
7918 _H	Reload Register LC	PRLC	R/W	16-bit PPG C/D	XXXXXXXX
7919 _H	Reload Register HC	PRLHC	R/W		XXXXXXXX
791A _H	Reload Register LD	PRLD	R/W		XXXXXXXX
791B _H	Reload Register HD	PRLHD	R/W		XXXXXXXX
791C _H	Reload Register LE	PRLLE	R/W	16-bit PPG E/F	XXXXXXXX
791D _H	Reload Register HE	PRLHE	R/W		XXXXXXXX
791E _H	Reload Register LF	PRLLE	R/W		XXXXXXXX
791F _H	Reload Register HF	PRLHF	R/W		XXXXXXXX
7920 _H	Input Capture Data Register 0	IPCP0	R	Input Capture 0/1	XXXXXXXX
7921 _H	Input Capture Data Register 0	IPCP0	R		XXXXXXXX
7922 _H	Input Capture Data Register 1	IPCP1	R		XXXXXXXX
7923 _H	Input Capture Data Register 1	IPCP1	R		XXXXXXXX

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
7924 _H	Input Capture Data Register 2	IPCP2	R	Input Capture 2/3	XXXXXXXX
7925 _H	Input Capture Data Register 2	IPCP2	R		XXXXXXXX
7926 _H	Input Capture Data Register 3	IPCP3	R		XXXXXXXX
7927 _H	Input Capture Data Register 3	IPCP3	R		XXXXXXXX
7928 _H	Input Capture Data Register 4	IPCP4	R	Input Capture 4/5	XXXXXXXX
7929 _H	Input Capture Data Register 4	IPCP4	R		XXXXXXXX
792A _H	Input Capture Data Register 5	IPCP5	R		XXXXXXXX
792B _H	Input Capture Data Register 5	IPCP5	R		XXXXXXXX
792C _H	Input Capture Data Register 6	IPCP6	R	Input Capture 6/7	XXXXXXXX
792D _H	Input Capture Data Register 6	IPCP6	R		XXXXXXXX
792E _H	Input Capture Data Register 7	IPCP7	R		XXXXXXXX
792F _H	Input Capture Data Register 7	IPCP7	R		XXXXXXXX
7930 _H	Output Compare Register 0	OCCP0	R/W	Output Compare 0/1	XXXXXXXX
7931 _H	Output Compare Register 0	OCCP0	R/W		XXXXXXXX
7932 _H	Output Compare Register 1	OCCP1	R/W		XXXXXXXX
7933 _H	Output Compare Register 1	OCCP1	R/W		XXXXXXXX
7934 _H	Output Compare Register 2	OCCP2	R/W	Output Compare 2/3	XXXXXXXX
7935 _H	Output Compare Register 2	OCCP2	R/W		XXXXXXXX
7936 _H	Output Compare Register 3	OCCP3	R/W		XXXXXXXX
7937 _H	Output Compare Register 3	OCCP3	R/W		XXXXXXXX
7938 _H	Output Compare Register 4	OCCP4	R/W	Output Compare 4/5	XXXXXXXX
7939 _H	Output Compare Register 4	OCCP4	R/W		XXXXXXXX
793A _H	Output Compare Register 5	OCCP5	R/W		XXXXXXXX
793B _H	Output Compare Register 5	OCCP5	R/W		XXXXXXXX
793C _H	Output Compare Register 6	OCCP6	R/W	Output Compare 6/7	XXXXXXXX
793D _H	Output Compare Register 6	OCCP6	R/W		XXXXXXXX
793E _H	Output Compare Register 7	OCCP7	R/W		XXXXXXXX
793F _H	Output Compare Register 7	OCCP7	R/W		XXXXXXXX
7940 _H	Data Register 0	TCDT0	R/W	I/O Timer 0	00000000
7941 _H	Data Register 0	TCDT0	R/W		00000000
7942 _H	Control Status Register 0	TCCSL0	R/W		00000000
7943 _H	Control Status Register 0	TCCSH0	R/W		0XXXXXXXX
7944 _H	Data Register 1	TCDT1	R/W	I/O Timer 1	00000000
7945 _H	Data Register 1	TCDT1	R/W		00000000
7946 _H	Control Status Register 1	TCCSL1	R/W		00000000
7947 _H	Control Status Register 1	TCCSH1	R/W		0XXXXXXXX

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
7948 _H	Timer Register 0/Reload Register 0	TMR0/ TMRLR0	R/W	16-bit Reload Timer 0	XXXXXXXX
7949 _H			R/W		XXXXXXXX
794A _H	Timer Register 1/Reload Register 1	TMR1/ TMRLR1	R/W	16-bit Reload Timer 1	XXXXXXXX
794B _H			R/W		XXXXXXXX
794C _H	Timer Register 2/Reload Register 2	TMR2/ TMRLR2	R/W	16-bit Reload Timer 2	XXXXXXXX
794D _H			R/W		XXXXXXXX
794E _H	Timer Register 3/Reload Register 3	TMR3/ TMRLR3	R/W	16-bit Reload Timer 3	XXXXXXXX
794F _H			R/W		XXXXXXXX
7950 _H	Serial Mode Register 3	SMR3	W, R/W	UART3	00000000
7951 _H	Serial Control Register 3	SCR3	W, R/W		00000000
7952 _H	Reception/Transmission Data Register 3	RDR3/ TDR3	R/W		00000000
7953 _H	Serial Status Register 3	SSR3	R, R/W		00001000
7954 _H	Extended Communication Control Reg. 3	ECCR3	R, W, R/W		000000XX
7955 _H	Extended Status/Control Register 3	ESCR3	R/W		00000100
7956 _H	Baud Rate Reload Register 30	BGR30	R/W		00000000
7957 _H	Baud Rate Reload Register 31	BGR31	R/W		00000000
7958 _H	Serial Mode Register 4	SMR4	W, R/W	UART4	00000000
7959 _H	Serial Control Register 4	SCR4	W, R/W		00000000
795A _H	Reception/Transmission Data Register 4	RDR4/ TDR4	R/W		00000000
795B _H	Serial Status Register 4	SSR4	R, R/W		00001000
795C _H	Extended Communication Control Reg. 4	ECCR4	R, W, R/W		000000XX
795D _H	Extended Status/Control Register 4	ESCR4	R/W		00000100
795E _H	Baud Rate Reload Register 40	BGR40	R/W		00000000
795F _H	Baud Rate Reload Register 41	BGR41	R/W		00000000
7960 _H to 796B _H	Reserved				
796C _H	Clock Output Enable Register	CLKR	R/W	Clock Monitor	XXXX0000
796D _H to 796F _H	Reserved				

(Continued)

MB90860A Series

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
7970 _H	I ² C Bus Status Register 0	IBSR0	R	I ² C Interface 0	00000000
7971 _H	I ² C Bus Control Register 0	IBCR0	W, R/W		00000000
7972 _H	I ² C 10-bit Slave Address Register 0	ITBAL0	R/W		00000000
7973 _H		ITBAH0	R/W		00000000
7974 _H	I ² C 10-bit Slave Address Mask Register 0	ITMKL0	R/W		11111111
7975 _H		ITMKH0	R/W		00111111
7976 _H	I ² C 7-bit Slave Address Register 0	ISBA0	R/W		00000000
7977 _H	I ² C 7-bit Slave Address Mask Register 0	ISMK0	R/W		01111111
7978 _H	I ² C Data Register 0	IDAR0	R/W		00000000
7979 _H , 797A _H	Reserved				
797B _H	I ² C Clock Control Register 0	ICCR0	R/W	I ² C Interface 0	00011111
797C _H to 797F _H	Reserved				
7980 _H	I ² C Bus Status Register 1	IBSR1	R	I ² C Interface 1	00000000
7981 _H	I ² C Bus Control Register 1	IBCR1	W, R/W		00000000
7982 _H	I ² C 10-bit Slave Address Register 1	ITBAL1	R/W		00000000
7983 _H		ITBAH1	R/W		00000000
7984 _H	I ² C 10-bit Slave Address Mask Register 1	ITMKL1	R/W		11111111
7985 _H		ITMKH1	R/W		00111111
7986 _H	I ² C 7-bit Slave Address Register 1	ISBA1	R/W		00000000
7987 _H	I ² C 7-bit Slave Address Mask Register 1	ISMK1	R/W		01111111
7988 _H	I ² C Data Register 1	IDAR1	R/W		00000000
7989 _H , 798A _H	Reserved				
798B _H	I ² C Clock Control Register 1	ICCR1	R/W	I ² C Interface 1	00011111
798C _H to 79C1 _H	Reserved				
79C2 _H	Clock Modulator Control Register	CMCR	R, R/W	Clock Modulator	0001X000
79C3 _H to 79DF _H	Reserved				

(Continued)

MB90860A Series

(Continued)

Address	Register	Abbrevia- tion	Access	Resource name	Initial value
79E0 _H	Program Address Detection Register 0	PADR0	R/W	Address Match Detection 0	XXXXXXXX
79E1 _H	Program Address Detection Register 0	PADR0	R/W		XXXXXXXX
79E2 _H	Program Address Detection Register 0	PADR0	R/W		XXXXXXXX
79E3 _H	Program Address Detection Register 1	PADR1	R/W		XXXXXXXX
79E4 _H	Program Address Detection Register 1	PADR1	R/W		XXXXXXXX
79E5 _H	Program Address Detection Register 1	PADR1	R/W		XXXXXXXX
79E6 _H	Program Address Detection Register 2	PADR2	R/W		XXXXXXXX
79E7 _H	Program Address Detection Register 2	PADR2	R/W		XXXXXXXX
79E8 _H	Program Address Detection Register 2	PADR2	R/W		XXXXXXXX
79E9 _H to 79EF _H	Reserved				
79F0 _H	Program Address Detection Register 3	PADR3	R/W	Address Match Detection 1	XXXXXXXX
79F1 _H	Program Address Detection Register 3	PADR3	R/W		XXXXXXXX
79F2 _H	Program Address Detection Register 3	PADR3	R/W		XXXXXXXX
79F3 _H	Program Address Detection Register 4	PADR4	R/W		XXXXXXXX
79F4 _H	Program Address Detection Register 4	PADR4	R/W		XXXXXXXX
79F5 _H	Program Address Detection Register 4	PADR4	R/W		XXXXXXXX
79F6 _H	Program Address Detection Register 5	PADR5	R/W		XXXXXXXX
79F7 _H	Program Address Detection Register 5	PADR5	R/W		XXXXXXXX
79F8 _H	Program Address Detection Register 5	PADR5	R/W		XXXXXXXX
79F9 _H to 7FFF _H	Reserved				

Notes : • Initial value of "X" represents unknown value.

- Addresses in the range 0000_H to 00BF_H, which are not listed in the table, are reserved for the primary functions of the MCU. A read access to these reserved addresses results reading "X" and any write access should not be performed.

■ INTERRUPT FACTORS, INTERRUPT VECTORS, INTERRUPT CONTROL REGISTER

Interrupt cause	EI ² OS clear	DMA ch number	Interrupt vector		Interrupt control register	
			Number	Address	Number	Address
Reset	N	—	#08	FFFFDC _H	—	—
INT9 instruction	N	—	#09	FFFFD8 _H	—	—
Exception	N	—	#10	FFFFD4 _H	—	—
(Reserved)	N	—	#11	FFFFD0 _H	ICR00	0000B0 _H
(Reserved)	N	—	#12	FFFFCC _H		
Input Capture 6	Y1	—	#13	FFFFC8 _H	ICR01	0000B1 _H
Input Capture 7	Y1	—	#14	FFFFC4 _H		
I ² C0	N	—	#15	FFFFC0 _H	ICR02	0000B2 _H
(Reserved)	N	—	#16	FFFFBC _H		
16-bit Reload Timer 0	Y1	0	#17	FFFFB8 _H	ICR03	0000B3 _H
16-bit Reload Timer 1	Y1	1	#18	FFFFB4 _H		
16-bit Reload Timer 2	Y1	2	#19	FFFFB0 _H	ICR04	0000B4 _H
16-bit Reload Timer 3	Y1	—	#20	FFFFAC _H		
PPG 0/1/4/5	N	—	#21	FFFFA8 _H	ICR05	0000B5 _H
PPG 2/3/6/7	N	—	#22	FFFFA4 _H		
PPG 8/9/C/D	N	—	#23	FFFFA0 _H	ICR06	0000B6 _H
PPG A/B/E/F	N	—	#24	FFFF9C _H		
Time Base Timer	N	—	#25	FFFF98 _H	ICR07	0000B7 _H
External Interrupt 0 to 3, 8 to 11	Y1	3	#26	FFFF94 _H		
Watch Timer	N	—	#27	FFFF90 _H	ICR08	0000B8 _H
External Interrupt 4 to 7, 12 to 15	Y1	4	#28	FFFF8C _H		
A/D Converter	Y1	5	#29	FFFF88 _H	ICR09	0000B9 _H
I/O Timer 0 / I/O Timer 1	N	—	#30	FFFF84 _H		
Input Capture 4/5 / I ² C1	Y1	6	#31	FFFF80 _H	ICR10	0000BA _H
Output Compare 0/1/4/5	Y1	7	#32	FFFF7C _H		
Input Capture 0 to 3	Y1	8	#33	FFFF78 _H	ICR11	0000BB _H
Output Compare 2/3/6/7	Y1	9	#34	FFFF74 _H		
UART 0 RX	Y2	10	#35	FFFF70 _H	ICR12	0000BC _H
UART 0 TX	Y1	11	#36	FFFF6C _H		
UART 1 RX / UART 3 RX	Y2	12	#37	FFFF68 _H	ICR13	0000BD _H
UART 1 TX / UART 3 TX	Y1	13	#38	FFFF64 _H		

(Continued)

MB90860A Series

(Continued)

Interrupt cause	EI ² OS clear	DMA ch number	Interrupt vector		Interrupt control register	
			Number	Address	Number	Address
UART 2 RX / UART 4 RX	Y2	14	#39	FFFF60 _H	ICR14	0000BE _H
UART 2 TX / UART 4 TX	Y1	15	#40	FFFF5C _H		
Flash Memory	N	—	#41	FFFF58 _H	ICR15	0000BF _H
Delayed interrupt	N	—	#42	FFFF54 _H		

Y1 : Usable

Y2 : Usable, with EI²OS stop function

N : Unusable

- Notes :
- The peripheral resources sharing the ICR register have the same interrupt level.
 - When two peripheral resources share the ICR register, only one can use Extended Intelligent I/O Service at a time.
 - When either of the two peripheral resources sharing the ICR register specifies Extended Intelligent I/O Service, the other one cannot use interrupts.

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

($V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
	AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_{CC} = AV_{CC}^{*1}$
	AV_{RH}, AV_{RL}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$AV_{CC} \geq AV_{RH}, AV_{CC} \geq AV_{RL}, AV_{RH} \geq AV_{RL}$
Input voltage	V_I	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*2
Output voltage	V_O	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	*2
Maximum Clamp Current	I_{CLAMP}	-4.0	+4.0	mA	*4
Total Maximum Clamp Current	$\Sigma I_{CLAMP} $	—	40	mA	*4
"L" level maximum output current	I_{OL}	—	15	mA	*3
"L" level average output current	I_{OLAV}	—	4	mA	*3
"L" level maximum overall output current	ΣI_{OL}	—	100	mA	*3
"L" level average overall output current	ΣI_{OLAV}	—	50	mA	*3
"H" level maximum output current	I_{OH}	—	-15	mA	*3
"H" level average output current	I_{OHAV}	—	-4	mA	*3
"H" level maximum overall output current	ΣI_{OH}	—	-100	mA	*3
"H" level average overall output current	ΣI_{OHAV}	—	-50	mA	*3
Power consumption	P_D	—	340	mW	MB90F867A
Operating temperature	T_A	-40	+105	°C	
Storage temperature	T_{STG}	-55	+150	°C	

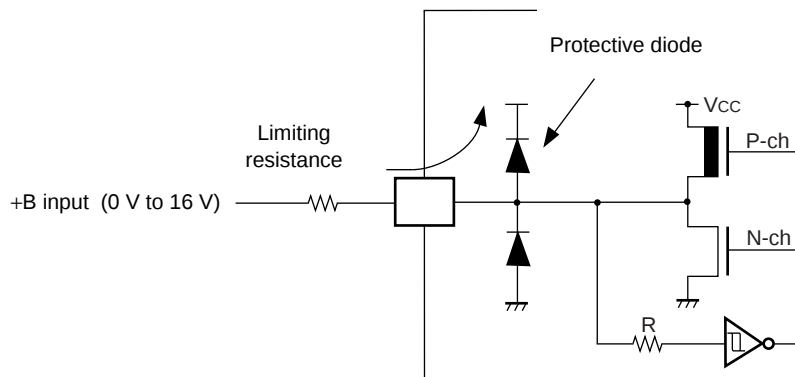
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MB90860A Series

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- *1: Set AV_{CC} and V_{CC} to the same voltage. Make sure that AV_{CC} does not exceed V_{CC} and that the voltage at the analog inputs does not exceed AV_{CC} when the power is switched on.
- *2: V_I and V_O should not exceed $V_{CC} + 0.3$ V. V_I should not exceed the specified ratings. However if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supercedes the V_I rating.
- *3: Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0 to PA1
- *4:
 - Applicable to pins: P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, PA0 to PA1
 - Use within recommended operating conditions.
 - Use at DC voltage (current)
 - The +B signal should always be applied a limiting resistance placed between the +B signal and the microcontroller.
 - The value of the limiting resistance should be set so that when the +B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
 - Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this may affect other devices.
 - Note that if a +B signal is input when the microcontroller power supply is off (not fixed at 0 V) , the power supply is provided from the pins, so that incomplete operation may result.
 - Note that if the +B input is applied during power-on, the power supply is provided from the pins and the resulting supply voltage may not be sufficient to operate the power-on reset.
 - Care must be taken not to leave the +B input pin open.
 - Sample recommended circuits:

- Input/output equivalent circuits

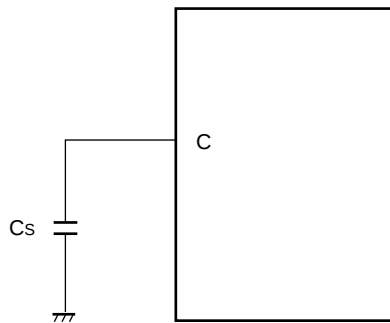


WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

2. Recommended Conditions

($V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC}, AV_{CC}	4.0	5.0	5.5	V	Under normal operation
		3.5	5.0	5.5	V	Under normal operation, when not using the A/D converter and not Flash programming.
		4.5	5.0	5.5	V	When External bus is used.
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smooth capacitor	C_S	0.1	—	1.0	μF	Use a ceramic capacitor or capacitor of better AC characteristics. Capacitor at the V_{CC} should be greater than this capacitor.
Operating temperature	T_A	-40	—	+105	$^{\circ}\text{C}$	



C Pin Connection Diagram

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

MB90860A Series

3. DC Characteristics

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input H voltage (At $V_{CC} = 5\text{ V} \pm 10\%$)	V_{IHS}	—	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	Port inputs if CMOS hysteresis input levels are selected (except UART SIN input pins and I ² C input pins)
	V_{IHA}	—	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	Port inputs if AUTOMOTIVE input levels are selected
	V_{IHT}	—	—	2.0	—	$V_{CC} + 0.3$	V	Port inputs if TTL input levels are selected
	V_{IHS}	—	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	UART SIN inputs if CMOS input levels are selected
	V_{IHI}	—	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	I ² C Port inputs if CMOS hysteresis input levels are selected
	V_{IHR}	—	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	R $\overline{\text{ST}}$ input pin (CMOS hysteresis)
	V_{IHM}	—	—	$V_{CC} - 0.3$	—	$V_{CC} + 0.3$	V	MD input pin
Input L voltage (At $V_{CC} = 5\text{ V} \pm 10\%$)	V_{ILS}	—	—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	Port inputs if CMOS hysteresis input levels are selected (except UART SIN input pins and I ² C input pins)
	V_{ILA}	—	—	$V_{SS} - 0.3$	—	$0.5 V_{CC}$	V	Port inputs if AUTOMOTIVE input levels are selected
	V_{ILT}	—	—	$V_{SS} - 0.3$	—	0.8	V	Port inputs if TTL input levels are selected
	V_{ILS}	—	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	UART SIN inputs if CMOS input levels are selected
	V_{ILI}	—	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	I ² C Port inputs if CMOS hysteresis input levels are selected
	V_{ILR}	—	—	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	R $\overline{\text{ST}}$ input pin (CMOS hysteresis)
	V_{ILM}	—	—	$V_{SS} - 0.3$	—	$V_{SS} + 0.3$	V	MD input pin
Output H voltage	V_{OH}	Normal outputs	$V_{CC} = 4.5\text{ V}$, $I_{OH} = -4.0\text{ mA}$	$V_{CC} - 0.5$	—	—	V	
Output H voltage	V_{OHI}	I ² C current outputs	$V_{CC} = 4.5\text{ V}$, $I_{OH} = -3.0\text{ mA}$	$V_{CC} - 0.5$	—	—	V	
Output L voltage	V_{OL}	Normal outputs	$V_{CC} = 4.5\text{ V}$, $I_{OL} = 4.0\text{ mA}$	—	—	0.4	V	
Output L voltage	V_{OLI}	I ² C current outputs	$V_{CC} = 4.5\text{ V}$, $I_{OL} = 3.0\text{ mA}$	—	—	0.4	V	

(Continued)

MB90860A Series

(Continued)

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input leak current	I_{IL}	—	$V_{CC} = 5.5\text{ V}$, $V_{SS} < V_I < V_{CC}$	-1	—	1	μA	
Pull-up resistance	R_{UP}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, $\overline{RST}$	—	25	50	100	$\text{k}\Omega$	
Pull-down resistance	R_{DOWN}	MD2	—	25	50	100	$\text{k}\Omega$	Except Flash devices
Power supply current*	I_{CC}	V_{CC}	$V_{CC} = 5.0\text{ V}$, Internal frequency : 24 MHz, At normal operation.	—	55	70	mA	MB90F867A
			$V_{CC} = 5.0\text{ V}$, Internal frequency : 24 MHz, At writing FLASH memory.	—	70	85	mA	MB90F867A
			$V_{CC} = 5.0\text{ V}$, Internal frequency : 24 MHz, At erasing FLASH memory.	—	75	90	mA	MB90F867A
	I_{CCS}		$V_{CC} = 5.0\text{ V}$, Internal frequency : 24 MHz, At Sleep mode.	—	25	35	mA	MB90F867A
	I_{CTS}		$V_{CC} = 5.0\text{ V}$, Internal frequency : 2 MHz, At Main Timer mode	—	0.3	0.8	mA	MB90F867A
	$I_{CTSPLL6}$		$V_{CC} = 5.0\text{ V}$, Internal frequency : 24 MHz, At PLL Timer mode, external frequency = 4 MHz	—	4	7	mA	MB90F867A
	I_{CCL}		$V_{CC} = 5.0\text{ V}$ Internal frequency: 8 kHz, At sub operation $T_A = +25^{\circ}\text{C}$	—	170	360	μA	MB90F867A
	I_{CCLS}		$V_{CC} = 5.0\text{ V}$ Internal frequency: 8 kHz, At sub sleep $T_A = +25^{\circ}\text{C}$	—	20	50	μA	MB90F867A
	I_{CCT}		$V_{CC} = 5.0\text{ V}$ Internal frequency: 8 kHz, At watch mode $T_A = +25^{\circ}\text{C}$	—	10	35	μA	MB90F867A
	I_{CCH}		$V_{CC} = 5.0\text{ V}$, At Stop mode, $T_A = +25^{\circ}\text{C}$	—	7	25	μA	MB90F867A
Input capacity	C_{IN}	Other than C, AV_{CC} , AV_{SS} , $AVRH$, $AVRL$, V_{CC} , V_{SS} ,	—	—	5	15	pF	

* : Current values are tentative. They are subject to change without notice according to improvements in the characteristics. The power supply current is measured with an external clock.

MB90860A Series

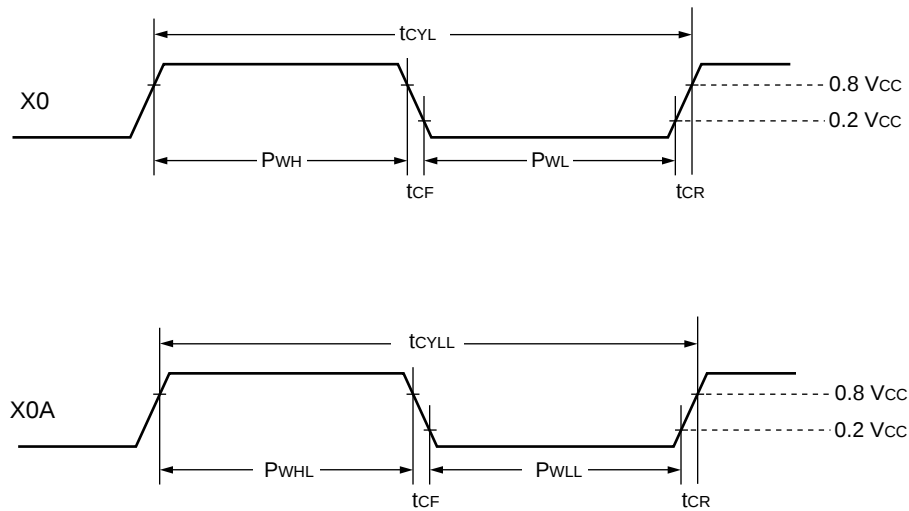
4. AC Characteristics

(1) Clock Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0\text{ V}$)

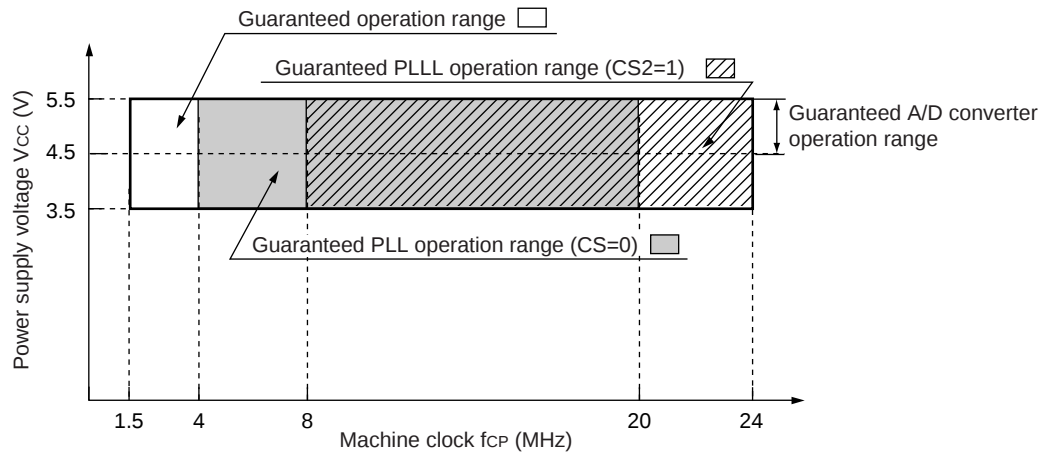
Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	f_c	X0, X1	3	—	16	MHz	When using an oscillation circuit
		X0	3	—	24	MHz	When using an external clock*
	f_{CL}	X0A, X1A	—	32.768	100	kHz	
Clock cycle time	t_{CYL}	X0, X1	62.5	—	333	ns	When using an oscillation circuit
		X0	41.67	—	333	ns	When using an external clock
	t_{CYLL}	X0A, X1A	10	30.5	—	μs	
Input clock pulse width	P_{WH}, P_{WL}	X0	10	—	—	ns	Duty ratio is about 30% to 70%.
	P_{WHL}, P_{WLL}	X0A	5	15.2	—	μs	
Input clock rise and fall time	t_{CR}, t_{CF}	X0	—	—	5	ns	When using external clock
Internal operating clock frequency (machine clock)	f_{CP}	—	1.5	—	24	MHz	When using main clock
	f_{CPL}	—	—	8.192	50	kHz	When using sub clock
Internal operating clock cycle time (machine clock)	t_{CP}	—	41.67	—	666	ns	When using main clock
	t_{CPL}	—	20	122.1	—	μs	When using sub clock

* : When selecting the PLL clock, the range of clock frequency is limited. Use this product within range as mentioned in "Relation among external clock frequency and machine clock frequency".



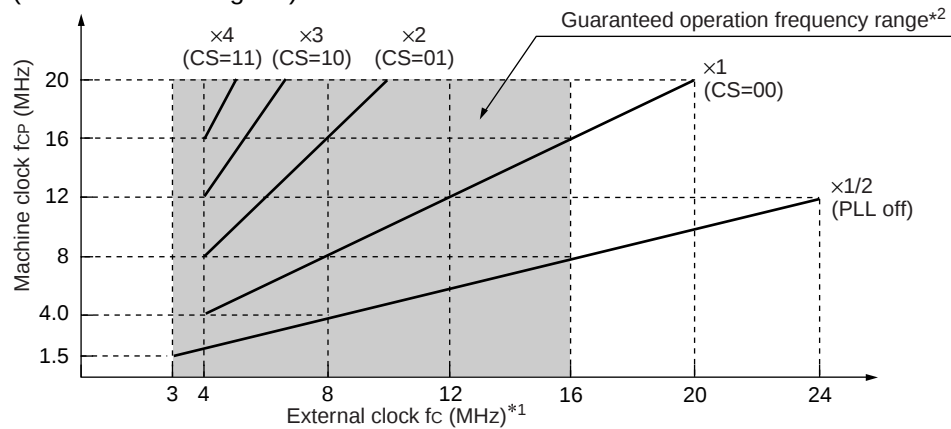
Clock Timing

- Guaranteed PLL operation range

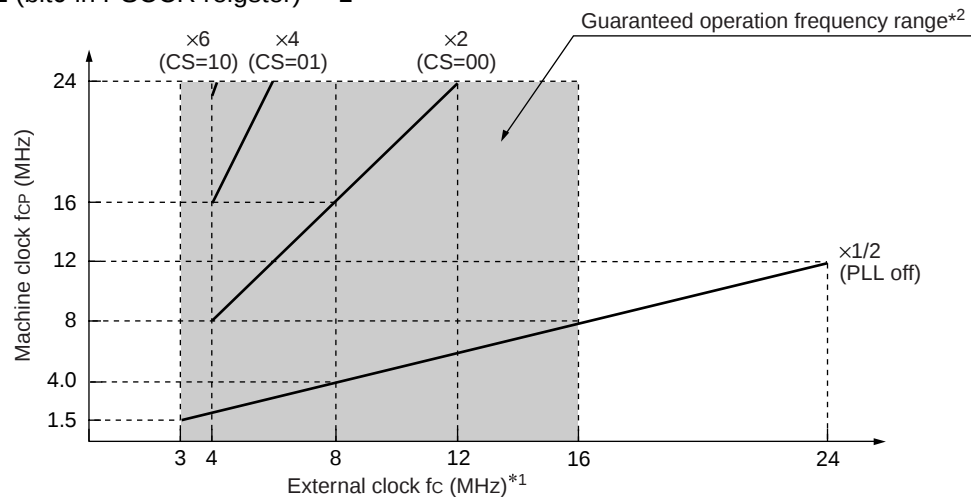


Guaranteed operation range of MB90860A Series

CS2 (bit0 in PSCCR reigster) = 0



CS2 (bit0 in PSCCR reigster) = 1



*1 : PLL $\times 1$ guaranteed operation range is from 4.0 MHz to 20 MHz.

*2 : When using a crystal oscillator or ceramic oscillator, the maximum oscillation clock frequency is 16 MHz.

External clock frequency and Machine clock frequency

MB90860A Series

(2) Reset Standby Input

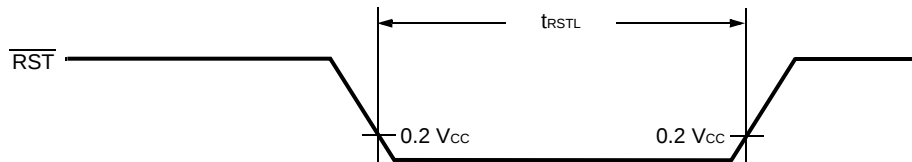
$$(T_A = -40\text{ }^{\circ}\text{C to } +105\text{ }^{\circ}\text{C}, V_{CC} = 5.0\text{ V} \pm 10\%, V_{SS} = AV_{SS} = 0.0\text{ V})$$

Parameter	Symbol	Pin	Value		Unit	Remarks
			Min	Max		
Reset input time	t _{RSTL}	$\overline{\text{RST}}$	500	—	ns	Under normal operation
			Oscillation time of oscillator* + 100 μs	—	ns	In Stop mode, Sub Clock mode, Sub Sleep mode and Watch mode
			100	—	μs	In Time Timer mode

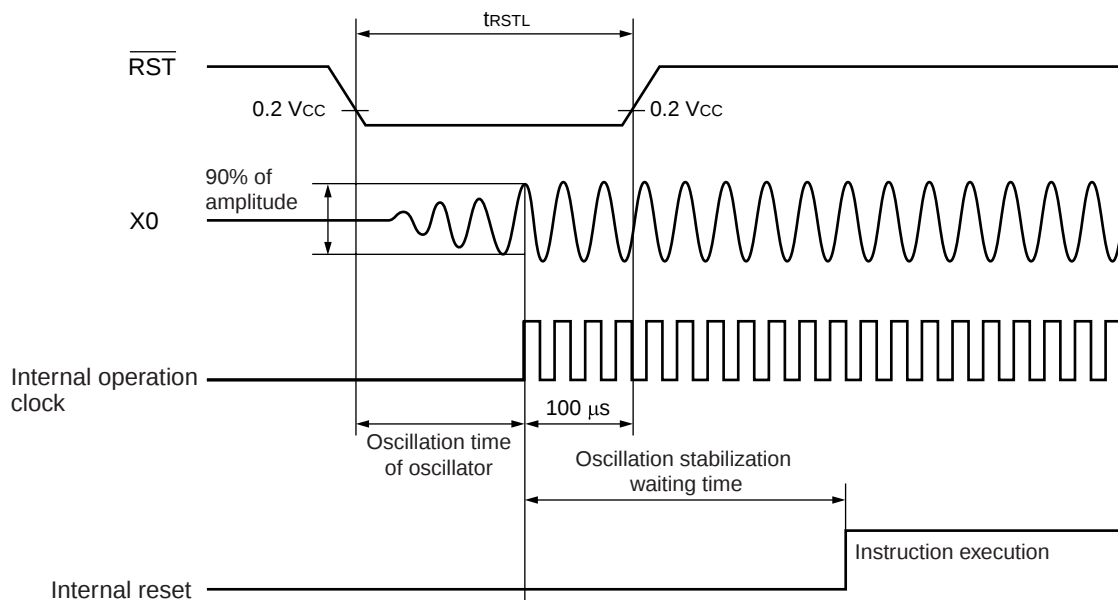
* : Oscillation time of oscillator is the time that the amplitude reaches 90%.

In the crystal oscillator, the oscillation time is between several ms and to tens of ms. In FAR / ceramic oscillators, the oscillation time is between hundreds of μ s to several ms. With an external clock, the oscillation time is 0 ms.

Under normal operation:



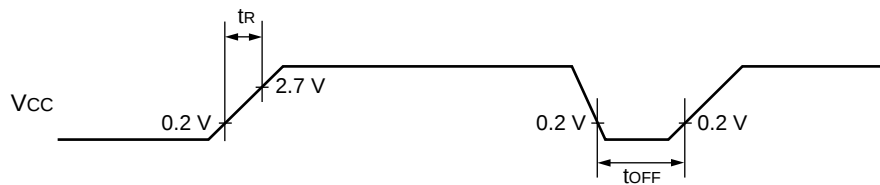
In Stop mode, Sub Clock mode, Sub Sleep mode, Watch mode:



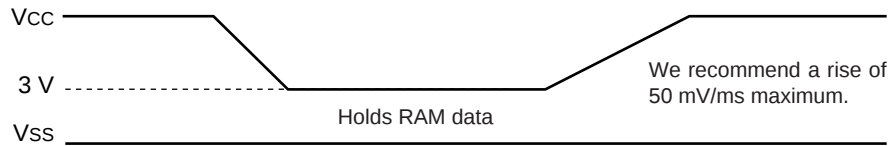
(3) Power On Reset

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Power on rise time	t_R	V_{CC}	—	0.05	30	ms	Due to repetitive operation
Power off time	t_{OFF}	V_{CC}		1	—	ms	



If you change the power supply voltage too rapidly, a power on reset may occur. We recommend that you startup smoothly by restraining voltages when changing the power supply voltage during operation, as shown in the figure below. Perform while not using the PLL clock. However, if voltage drops are within 1 V/s, you can operate while using the PLL clock.

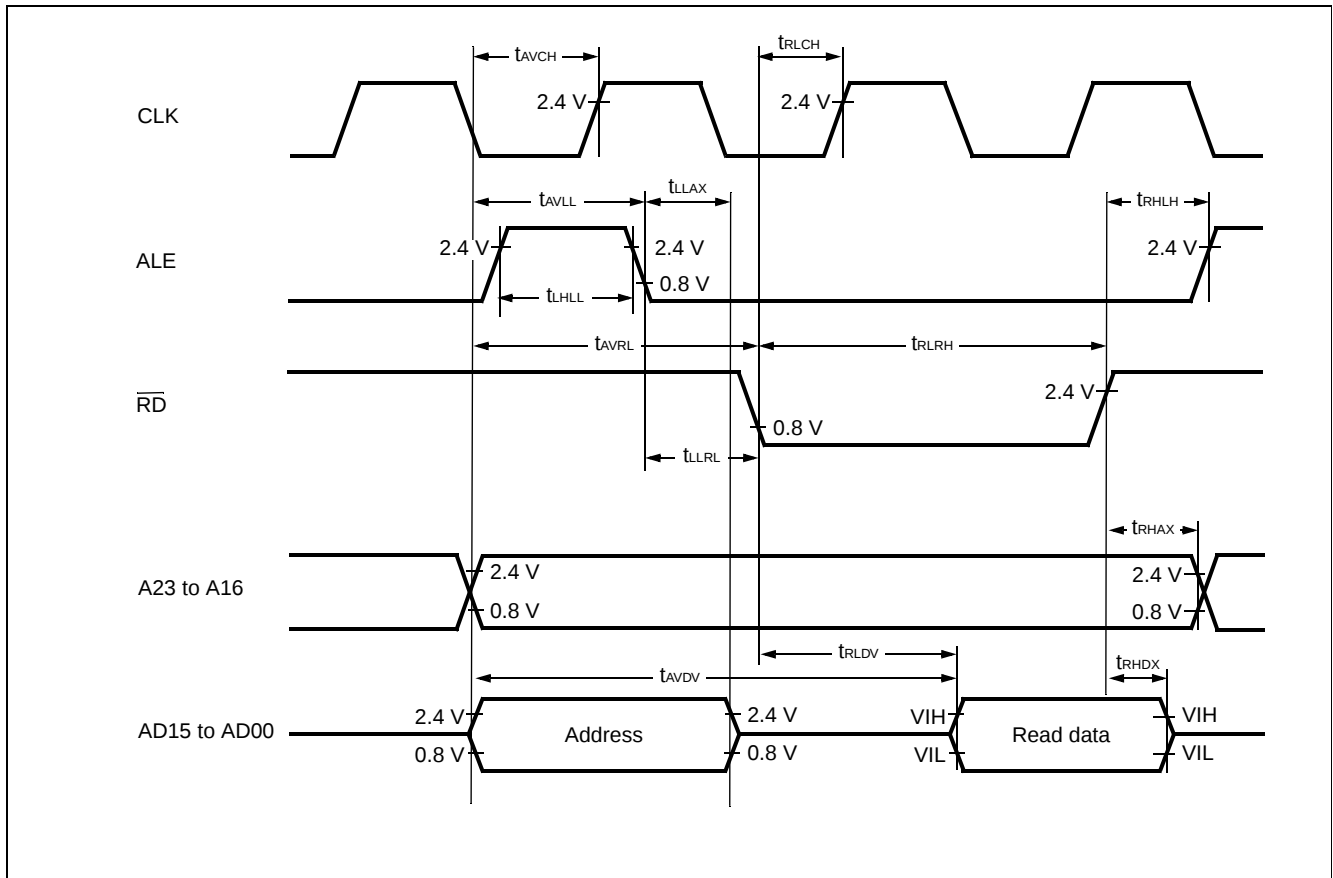


MB90860A Series

(4) Bus Timing (Read)

($T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0.0\text{ V}$, Machine Clock $\leq 16\text{ MHz}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
ALE pulse width	t_{LHLL}	ALE	—	$t_{CP}/2 - 10$	—	ns	
Valid address $\Rightarrow$ ALE $\downarrow$ time	t_{AVLL}	ALE, A23 to A16, AD15 to AD00		$t_{CP}/2 - 15$	—	ns	
ALE $\downarrow \Rightarrow$ Address valid time	t_{LLAX}	ALE, AD15 to AD00		$t_{CP}/2 - 15$	—	ns	
Valid address $\Rightarrow \overline{RD} \downarrow$ time	t_{AVRL}	A23 to A16, AD15 to AD00, $\overline{RD}$		$t_{CP} - 15$	—	ns	
Valid address $\Rightarrow$ Valid data input	t_{AVDV}	A23 to A16, AD15 to AD00		—	$5 t_{CP}/2 - 40$	ns	
$\overline{RD}$ pulse width	t_{RLRH}	$\overline{RD}$		$3 t_{CP}/2 - 20$	—	ns	
$\overline{RD} \downarrow \Rightarrow$ Valid data input	t_{RLDV}	$\overline{RD}$, AD15 to AD00		—	$3 t_{CP}/2 - 50$	ns	
$\overline{RD} \uparrow \Rightarrow$ Data hold time	t_{RHDX}	$\overline{RD}$, AD15 to AD00		0	—	ns	
$\overline{RD} \downarrow \Rightarrow$ ALE $\uparrow$ time	t_{RHLH}	$\overline{RD}$, ALE		$t_{CP}/2 - 15$	—	ns	
$\overline{RD} \uparrow \Rightarrow$ Address valid time	t_{RHAX}	$\overline{RD}$, A23 to A16		$t_{CP}/2 - 10$	—	ns	
Valid address $\Rightarrow$ CLK $\uparrow$ time	t_{AVCH}	A23 to A16, AD15 to AD00, CLK		$t_{CP}/2 - 15$	—	ns	
$\overline{RD} \downarrow \Rightarrow$ CLK $\uparrow$ time	t_{RLCH}	$\overline{RD}$, CLK		$t_{CP}/2 - 15$	—	ns	
ALE $\downarrow \Rightarrow \overline{RD} \downarrow$ time	t_{LLRL}	ALE, $\overline{RD}$		$t_{CP}/2 - 15$	—	ns	

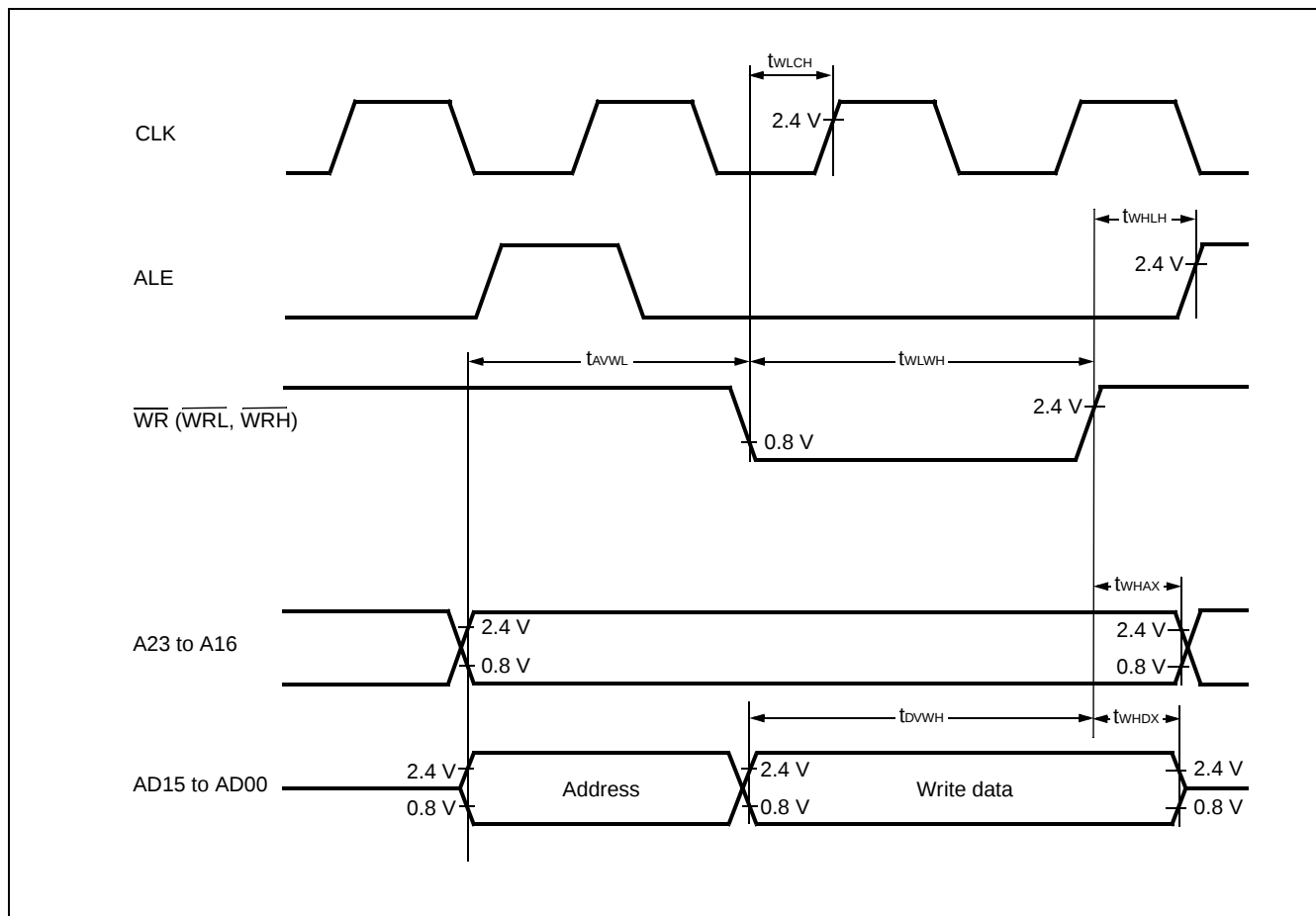


MB90860A Series

(5) Bus Timing (Write)

($T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0.0\text{ V}$, Machine Clock $\leq 16\text{ MHz}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Valid address $\Rightarrow \overline{\text{WR}} \downarrow$ time	t_{AVWL}	A23 to A16, AD15 to AD00, $\overline{\text{WR}}$	—	$t_{\text{CP}} - 15$	—	ns	
$\overline{\text{WR}}$ pulse width	t_{WLWH}	$\overline{\text{WR}}$		$3 t_{\text{CP}}/2 - 20$	—	ns	
Valid data output $\Rightarrow \overline{\text{WR}} \uparrow$ time	t_{DVWH}	AD15 to AD00, $\overline{\text{WR}}$		$3 t_{\text{CP}}/2 - 20$	—	ns	
$\overline{\text{WR}} \uparrow \Rightarrow$ Data hold time	t_{WHDX}	AD15 to AD00, $\overline{\text{WR}}$		15	—	ns	
$\overline{\text{WR}} \uparrow \Rightarrow$ Address valid time	t_{WHAX}	A23 to A16, $\overline{\text{WR}}$		$t_{\text{CP}}/2 - 10$	—	ns	
$\overline{\text{WR}} \uparrow \Rightarrow \text{ALE} \uparrow$ time	t_{WHLH}	$\overline{\text{WR}}$, ALE		$t_{\text{CP}}/2 - 15$	—	ns	
$\overline{\text{WR}} \downarrow \Rightarrow \text{CLK} \uparrow$ time	t_{WLCH}	$\overline{\text{WR}}$, CLK		$t_{\text{CP}}/2 - 15$	—	ns	

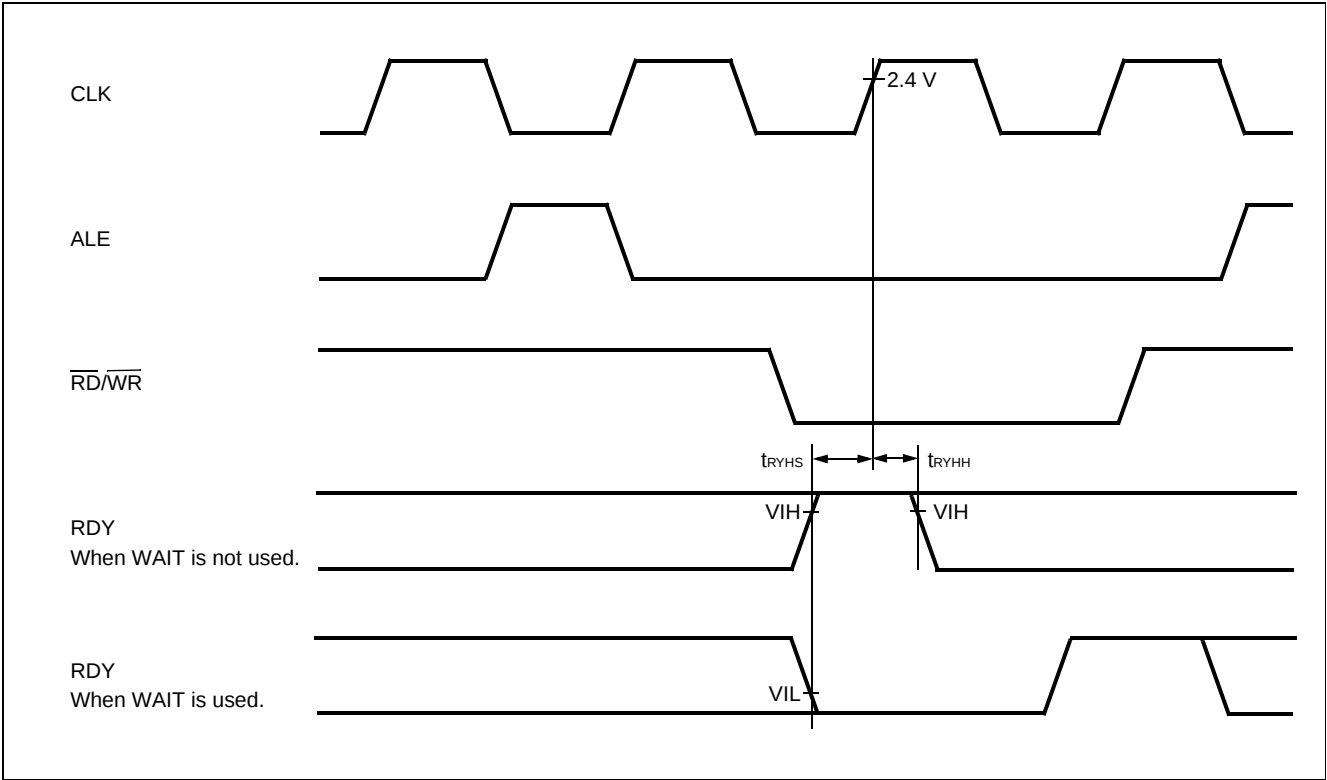


(6) Ready Input Timing

($T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0.0\text{ V}$, Machine Clock $\leq 16\text{ MHz}$)

Parameter	Sym- bol	Pin	Test Condition	Value		Units	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	45	—	ns	
RDY hold time	t_{RYHH}	RDY		0	—	ns	

Note : If the RDY setup time is insufficient, use the auto-ready function.



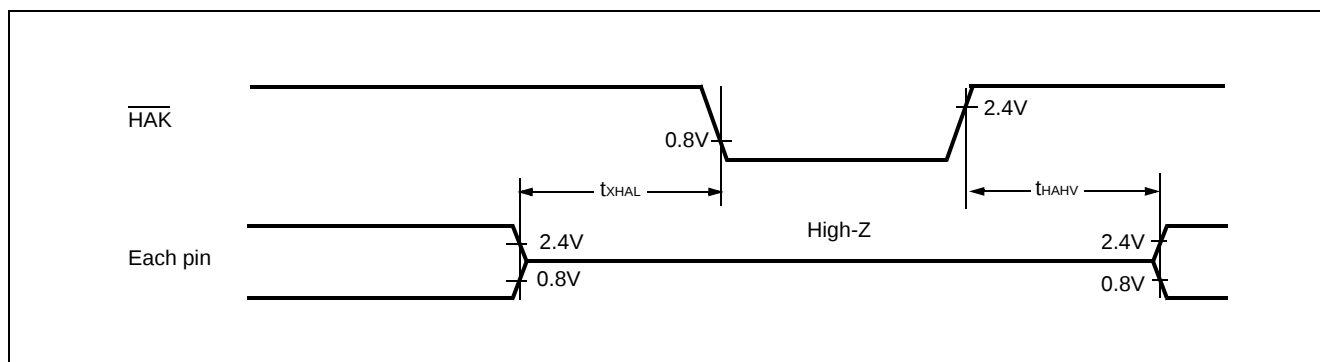
MB90860A Series

(7) Hold Timing

($T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0.0\text{ V}$, Machine Clock $\leq 16\text{ MHz}$)

Parameter	Symbol	Pin	Condition	Value		Units	Remarks
				Min	Max		
Pin floating $\Rightarrow \overline{\text{HAK}} \downarrow$ time	t_{XHAL}	$\overline{\text{HAK}}$	—	30	t_{CP}	ns	
$\overline{\text{HAK}} \uparrow$ time $\Rightarrow$ Pin valid time	t_{HAHV}	$\overline{\text{HAK}}$		t_{CP}	$2 t_{\text{CP}}$	ns	

Note : There is more than 1 cycle from when HRQ reads in until the $\overline{\text{HAK}}$ is changed.

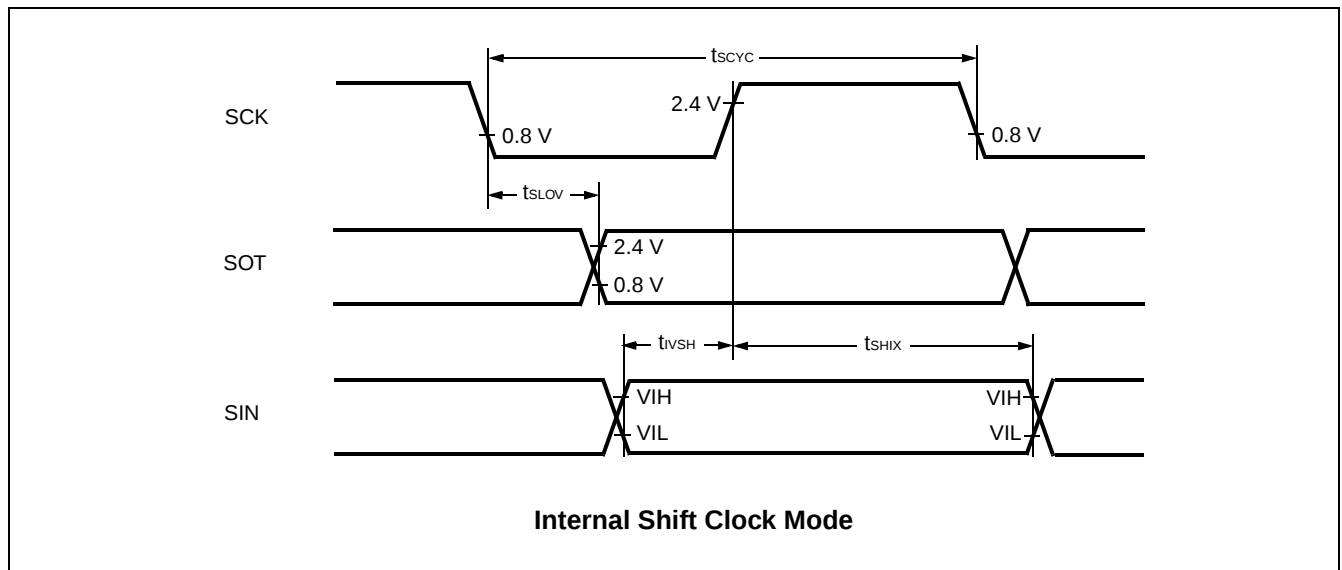


(8) UART0/1/2/3/4

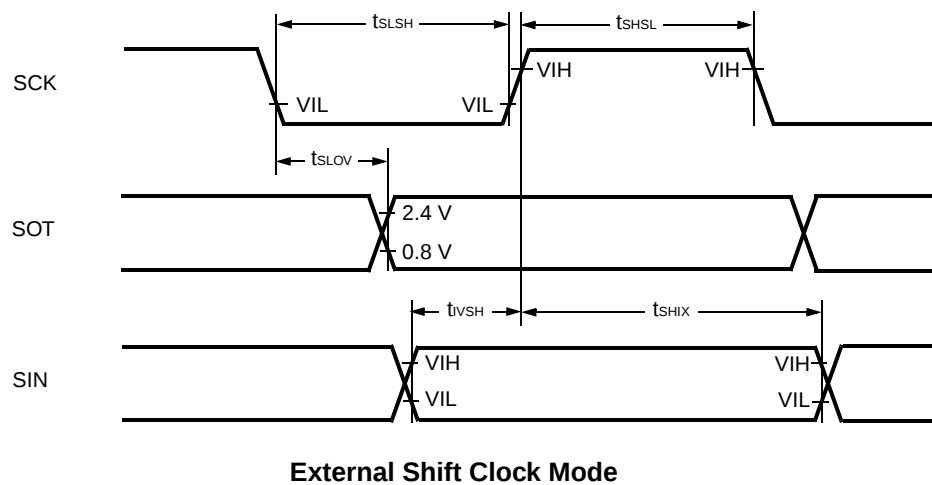
($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK0 to SCK4	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$8\ t_{CP}$	—	ns	
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOV}	SCK0 to SCK4, SOT0 to SOT4		-80	+80	ns	
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSH}	SCK0 to SCK4, SIN0 to SIN4		100	—	ns	
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIX}	SCK0 to SCK4, SIN0 to SIN4		60	—	ns	
Serial clock "H" pulse width	t_{SHSL}	SCK0 to SCK4	External clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$4\ t_{CP}$	—	ns	
Serial clock "L" pulse width	t_{SLSH}	SCK0 to SCK4		$4\ t_{CP}$	—	ns	
SCK $\downarrow \rightarrow$ SOT delay time	t_{SLOV}	SCK0 to SCK4, SOT0 to SOT4		—	150	ns	
Valid SIN $\rightarrow$ SCK $\uparrow$	t_{IVSH}	SCK0 to SCK4, SIN0 to SIN4		60	—	ns	
SCK $\uparrow \rightarrow$ Valid SIN hold time	t_{SHIX}	SCK0 to SCK4, SIN0 to SIN4		60	—	ns	

- Notes :
- AC characteristic in CLK synchronized mode.
 - C_L is load capacity value of pins when testing.
 - t_{CP} is the machine cycle (Unit : ns)



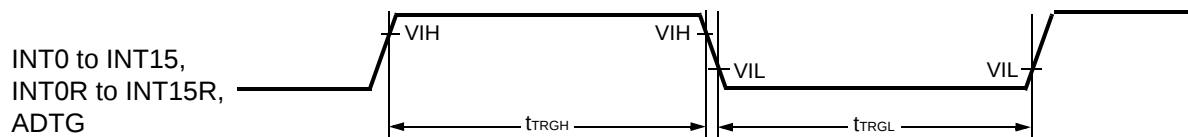
MB90860A Series



(9) Trigger Input Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$)

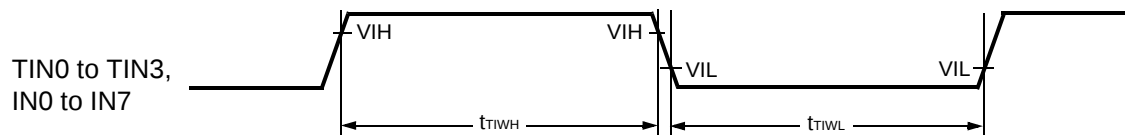
Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH} t_{TRGL}	INT0 to INT15, INT0R to INT15R, ADTG	—	$5\ t_{CP}$	—	ns	



(10) Timer Related Resource Input Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0\text{ V}$)

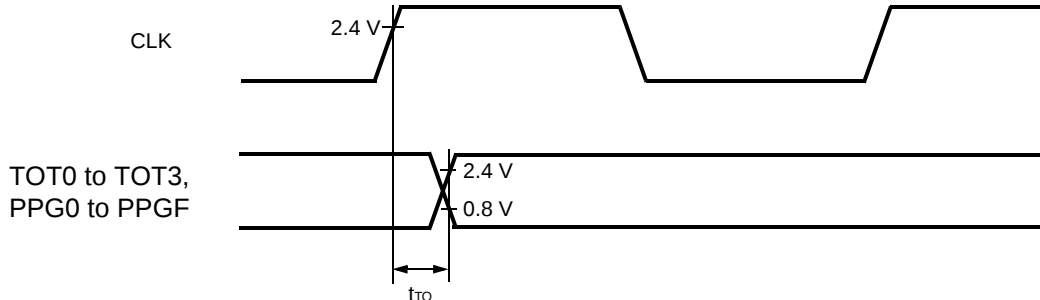
Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TIWH}	TIN0 to TIN3 IN0 to IN7	—	$4 t_{CP}$	—	ns	
	t_{TIWL}						



(11) Timer Related Resource Output Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $V_{CC} = 4.5\text{ V}$ to 5.5 V , $V_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
CLK $\uparrow \Rightarrow T_{OUT}$ change time	t_{TO}	TOT0 to TOT3, PPG0 to PPGF	—	30	—	ns	



MB90860A Series

(12) I²C Timing

(T_A = -40°C to +105°C, V_{CC} = 4.5 V to 5.5 V, V_{SS} = 0.0 V)

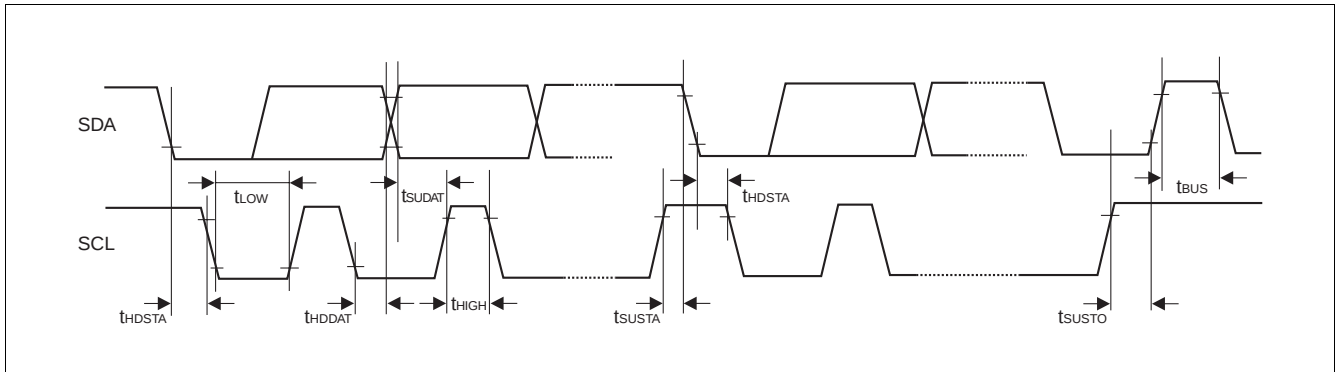
Parameter	Symbol	Condition	Standard-mode		Fast-mode* ⁴		Unit
			Min	Max	Min	Max	
SCL clock frequency	f _{SCL}	R = 1.7 kΩ, C = 50 pF* ¹	0	100	0	400	kHz
Hold time (repeated) START condition SDA ↓ → SCL ↓	t _{HDSTA}		4.0	—	0.6	—	μs
"L" width of the SCL clock	t _{LOW}		4.7	—	1.3	—	μs
"H" width of the SCL clock	t _{HIGH}		4.0	—	0.6	—	μs
Set-up time for a repeated START condition SCL ↑ → SDA ↓	t _{SUSTA}		4.7	—	0.6	—	μs
Data hold time SCL ↓ → SDA ↓ ↑	t _{HDDAT}		0	3.45* ²	0	0.9* ³	μs
Data set-up time SDA ↓ ↑ → SCL ↑	t _{SUDAT}		250	—	100	—	ns
Set-up time for STOP condition SCL ↑ → SDA ↑	t _{SUSTO}		4.0	—	0.6	—	μs
Bus free time between a STOP and START condition	t _{BUS}		4.7	—	1.3	—	μs

*1 : R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

*2 : The maximum t_{HDDAT} only has to be met if the device does not stretch the "L" width (t_{LOW}) of the SCL signal.

*3 : A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement t_{SUDAT} ≥ 250 ns must then be met.

*4 : For use at over 100 kHz, set the machine clock to at least 6 MHz.



5. A/D Converter

($T_A = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$, $3.0\text{ V} \leq \text{AVRH} - \text{AVRL}$, $V_{CC} = \text{AV}_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = \text{AV}_{SS} = 0\text{ V}$)

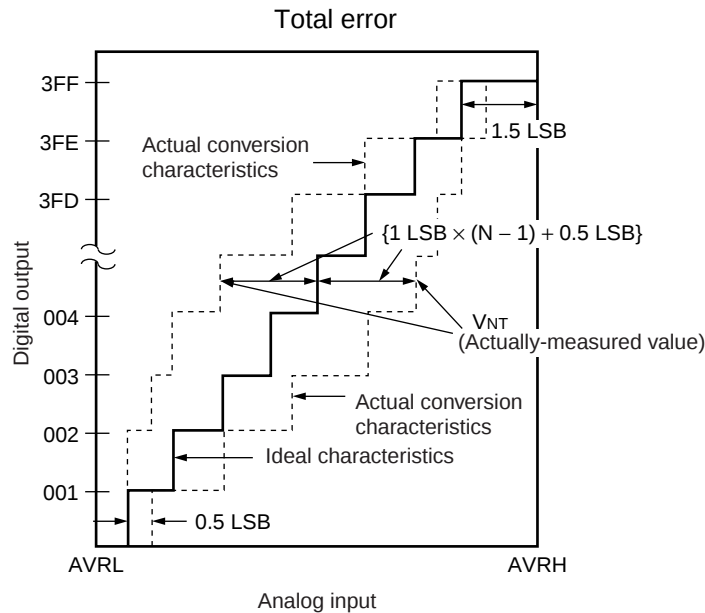
Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Total error	—	—	—	—	± 3.0	LSB	
Nonlinearity error	—	—	—	—	± 2.5	LSB	
Differential nonlinearity error	—	—	—	—	± 1.9	LSB	
Zero reading voltage	V_{OT}	AN0 to AN23	$\text{AVRL} - 1.5$	$\text{AVRL} + 0.5$	$\text{AVRL} + 2.5$	LSB	
Full scale reading voltage	V_{FST}	AN0 to AN23	$\text{AVRH} - 3.5$	$\text{AVRH} - 1.5$	$\text{AVRH} + 0.5$	LSB	
Compare time	—	—	1.0	—	16,500	μs	$4.5\text{ V} \leq \text{AV}_{CC} \leq 5.5\text{ V}$
			2.0				$4.0\text{ V} \leq \text{AV}_{CC} < 4.5\text{ V}$
Sampling time	—	—	0.5	—	∞	μs	$4.5\text{ V} \leq \text{AV}_{CC} \leq 5.5\text{ V}$
			1.2				$4.0\text{ V} \leq \text{AV}_{CC} < 4.5\text{ V}$
Analog port input current	I_{AIN}	AN0 to AN23	-0.3	—	+0.3	μA	
Analog input voltage range	V_{AIN}	AN0 to AN23	AVRL	—	AVRH	V	
Reference voltage range	—	AVRH	$\text{AVRL} + 2.7$	—	AV_{CC}	V	
	—	AVRL	0	—	$\text{AVRH} - 2.7$	V	
Power supply current	I_A	AV_{CC}	—	3.5	7.5	mA	
	I_{AH}	AV_{CC}	—	—	5	μA	*
Reference voltage current	I_R	AVRH	—	600	900	μA	
	I_{RH}	AVRH	—	—	5	μA	*
Offset between input channels	—	AN0 to AN23	—	—	4	LSB	

* : When not operating A/D converter, this is the current ($V_{CC} = \text{AV}_{CC} = \text{AVRH} = 5.0\text{ V}$) .

Note : The accuracy gets worse as $\text{AVRH} - \text{AVRL}$ becomes smaller.

6. Definition of A/D Converter Terms

Resolution	: Analog variation that is recognized by an A/D converter.
Non linearity error	: Deviation between a line across zero-transition line ("00 0000 0000" $\leftarrow \rightarrow$ "00 0000 0001") and full-scale transition line ("11 1111 1110" $\leftarrow \rightarrow$ "11 1111 1111") and actual conversion characteristics.
Differential linearity error	: Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.
Total error	: Difference between an actual value and an ideal value. A total error includes zero transition error, full-scale transition error, and linear error.
Zero reading voltage	: Input voltage which results in the minimum conversion value.
Full scale reading voltage	: Input voltage which results in the maximum conversion value.



$$\text{Total error of digital output "N"} = \frac{V_{NT} - \{1 \text{ LSB} \times (N - 1) + 0.5 \text{ LSB}\}}{1 \text{ LSB}} \quad [\text{LSB}]$$

$$1 \text{ LSB} = (\text{Ideal value}) \frac{AVRH - AVRL}{1024} \quad [\text{V}]$$

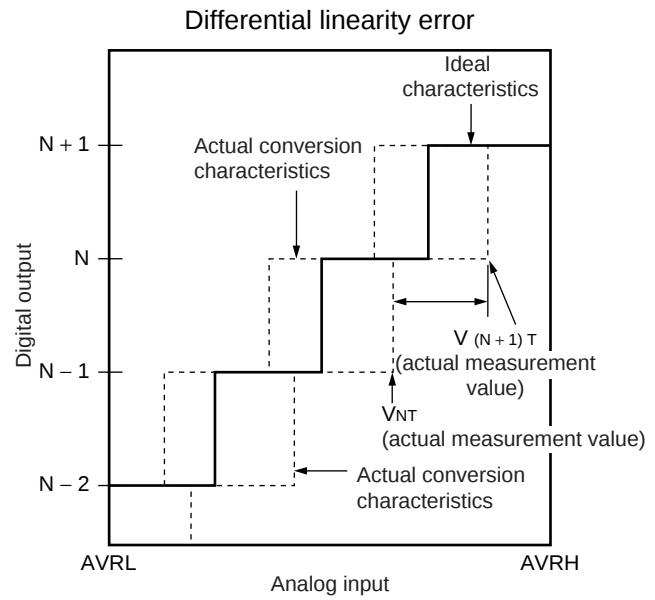
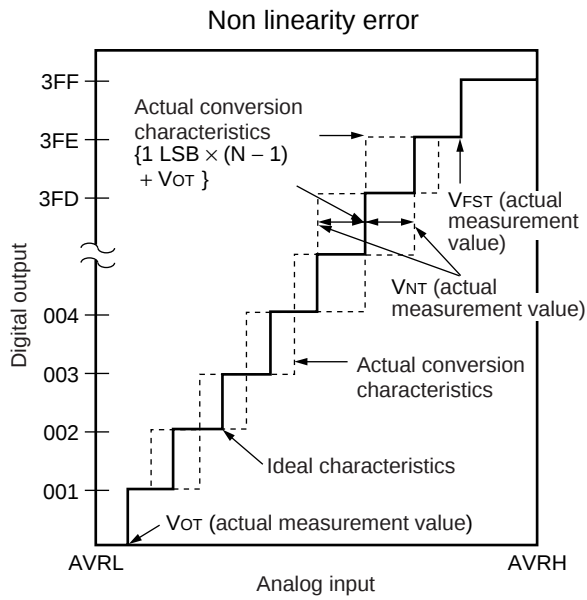
$$V_{OT} (\text{Ideal value}) = AVRL + 0.5 \text{ LSB} \quad [\text{V}]$$

$$V_{FST} (\text{Ideal value}) = AVRH - 1.5 \text{ LSB} \quad [\text{V}]$$

V_{NT} : A voltage at which digital output transitions from (N - 1) to N.

(Continued)

(Continued)



$$\text{Non linearity error of digital output } N = \frac{V_{NT} - \{1 \text{ LSB} \times (N-1) + V_{OT}\}}{1 \text{ LSB}} [\text{LSB}]$$

$$\text{Differential linearity error of digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}} - 1 \text{ LSB} [\text{LSB}]$$

$$1 \text{ LSB} = \frac{V_{FST} - V_{OT}}{1022} [\text{V}]$$

V_{OT} : Voltage at which digital output transits from "000_H" to "001_H."

V_{FST} : Voltage at which digital output transits from "3FE_H" to "3FF_H."

MB90860A Series

7. Notes on A/D Converter Section

Use the device with external circuits of the following output impedance for analog inputs :

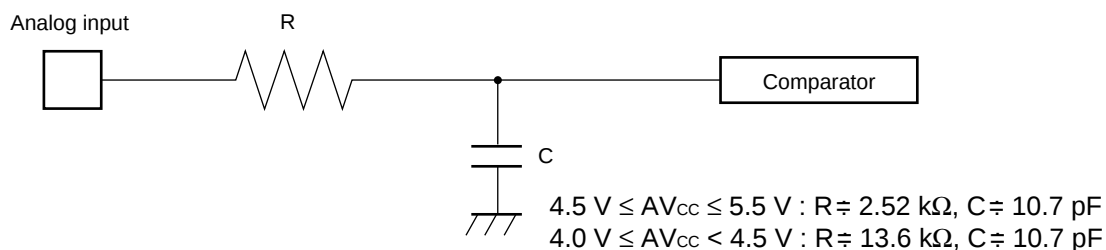
Recommended output impedance of external circuits are : Approx. 1.5 k Ω or lower ($4.0\text{ V} \leq AV_{CC} \leq 5.5\text{ V}$, sampling period $\leq 0.5\text{ }\mu\text{s}$)

if the output impedance exceeds 1.5 k Ω , set a longer sampling time or add an external capacitor compensate the output impedance. About setting of sampling time, please refer to hardware manual of MB90860A series.

If an external capacitor is used, in consideration of the effect by tap capacitance caused by external capacitors and on-chip capacitors, capacitance of the external one is recommended to be several thousand times as high as internal capacitor.

If output impedance of an external circuit is too high, a sampling period for an analog voltage may be insufficient.

• Analog input circuit model



Note : Use the values in the figure only as a guideline.

8. Flash Memory Program/Erase Characteristics

Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	T _A = +25 °C V _{CC} = 5.0 V	—	1	15	s	Excludes programming prior to erasure
Chip erase time		—	9	—	s	Excludes programming prior to erasure
Word (16 bit width) programming time		—	16	3,600	μ s	Except for the over head time of the system
Programs/Erase cycle	—	10,000	—	—	cycle	
Flash Data Retention Time	Average T _A = +85 °C	20	—	—	Year	*

* : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at + 85 °C) .

■ ORDERING INFORMATION

Part number	Package	Remarks
MB90F867APF	100-pin Plastic QFP (FPT-100P-M06)	
MB90F867ASPF		
MB90867APF		
MB90867ASPF		
MB90F867APFV	100-pin Plastic LQFP (FPT-100P-M05)	
MB90F867ASPFV		
MB90867APFV		
MB90867ASPFV		
MB90V340	299-pin Ceramic PGA (PGA-299C-A01)	For evaluation
MB90V340S		

MB90860A Series

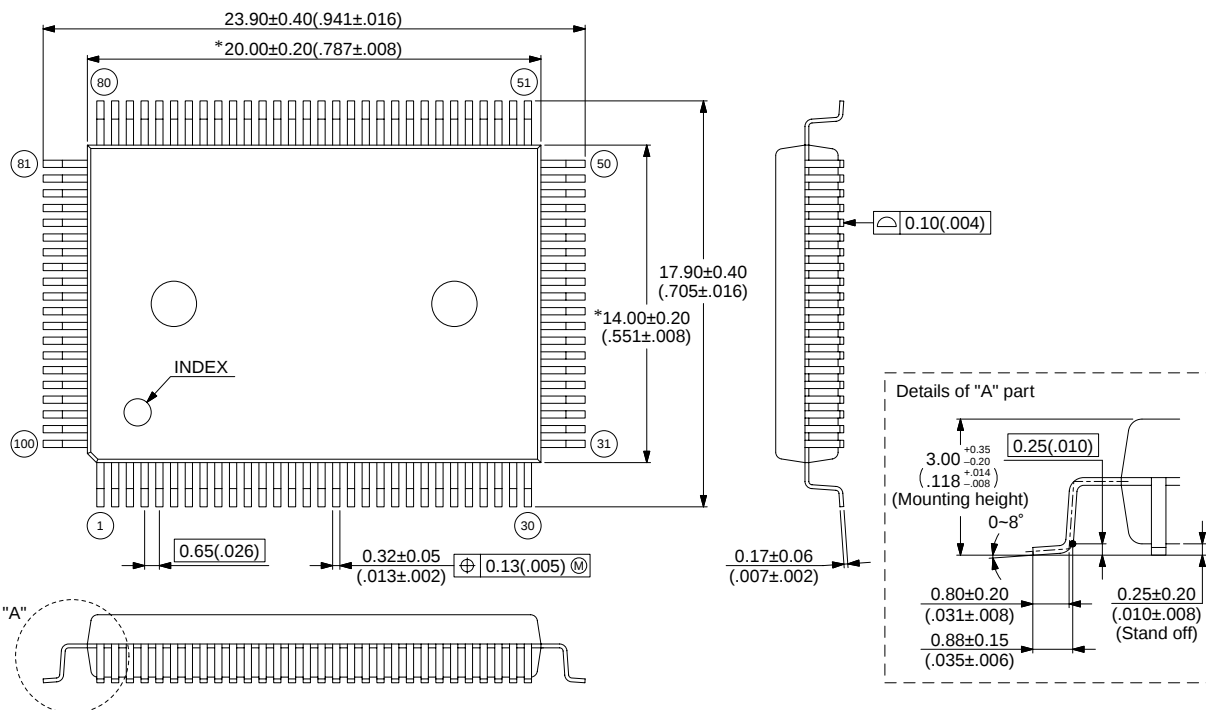
■ PACKAGE DIMENSIONS

100-pin Plastic QFP
(FPT-100P-M06)

Note 1) * : These dimensions do not include resin protrusion.

Note 2) Pins width and pins thickness including plating thickness.

Note 3) Pins width do not include tie bar cutting remainder.



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Dimensions in mm (inches)

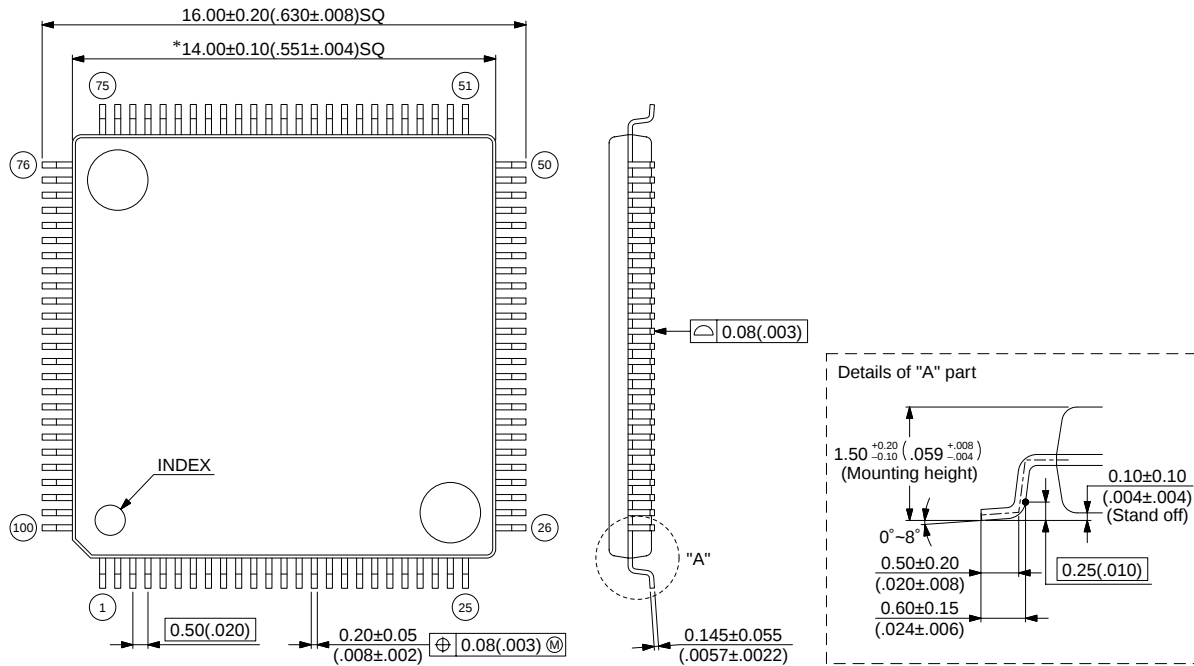
Note : The values in parentheses are reference values.

(Continued)

(Continued)

100-pin Plastic LQFP
(FPT-100P-M05)

Note 1) * : These dimensions do not include resin protrusion.
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.



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Dimensions in mm (inches)

Note : The values in parentheses are reference values.

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